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<b>Title</b>	<b><i>PLC810PG based 414W PSU for Lead Battery Charger</i></b>
<b>Specification</b>	<b>140 VAC to 290 VAC Input 418 W Total Output Power 5 V<sub>SB</sub> at 1 W 12 V<sub>SB</sub> at 3 W 41.4 V at 414 W</b>
<b>Application</b>	Battery Charger
<b>Author</b>	EISEA Greenhouse Team
<b>Document Number</b>	
<b>Date</b>	May 11, 2009
<b>Revision</b>	0.1

### **Summary and Features**

- Wide input voltage range 140-290VAC
- Uses integrated PFC and LLC controller PLC810
- Power factor corrected.
- Typical total efficiency 92%.
- Constant voltage and constant current output.
- Brownout shutdown circuit included
- Standby power of 0.5W output power available with <1W input power
- No-load input power < 250 mW @230 VAC

### **PATENT INFORMATION**

The products and applications illustrated herein (including transformer construction and circuits external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at [www.powerint.com](http://www.powerint.com). Power Integrations grants its customers a license under certain patent rights as set forth at <http://www.powerint.com/ip.htm>.

# 1 Table of Contents

- 1 Table of Contents .....2
- 2 Introduction.....4
- 3 Power Supply Specification .....5
- 4 Schematic.....6
- 5 Circuit Description ..... 11
  - 5.1 Input Filter/Boost Converter..... 11
    - 5.1.1 EMI Filtering ..... 11
    - 5.1.2 Inrush limiting ..... 11
    - 5.1.3 Main PFC Stage..... 11
  - 5.2 Main LLC Output ..... 11
    - 5.2.1 LLC Input Stage ..... 12
    - 5.2.2 LLC Output..... 12
  - 5.3 Controller..... 12
    - 5.3.1 PFC Control ..... 12
    - 5.3.2 Bypassing/Ground Isolation ..... 12
    - 5.3.3 LLC Control ..... 12
  - 5.4 LLC Secondary Control Circuits ..... 13
    - 5.4.1 Voltage and Current Feedback ..... 13
  - 5.5 Flyback Power Supply ..... 13
    - 5.5.1 5V/12V Flyback Supply ..... 13
    - 5.5.2 Primary Bias regulator/Remote Start..... 13
    - 5.5.3 Brownout Shutdown Circuit ..... 14
- PCB Layout ..... 15
- 6 Bill of Materials ..... 16
- 7 Main LLC Transformer (T2) Specification ..... 23
  - 7.1 Electrical Diagram ..... 23
  - 7.2 Electrical Specifications..... 23
- 8 Flyback Transformer (T1) ..... 24
  - 8.1 Electrical Diagram ..... 24
  - 8.2 Electrical Specifications..... 24
  - 8.3 Materials..... 24
  - 8.4 Build Diagram..... 24
  - 8.5 Construction ..... 25
- 9 PFC Choke Specification (L4) ..... 26
  - 9.1 Electrical Diagram ..... 26
  - 9.2 Electrical Specification ..... 26
  - 9.3 Materials..... 26
  - 9.4 Build Diagram..... 26
  - 9.5 Winding Instructions ..... 27
- 10 LLC Spreadsheet ..... 28
- 11 Performance Data ..... 33
  - 11.1.1 Composite Efficiency..... 33
  - 11.2 Standby Load Input Power ..... 34

11.2.1	No-Load Input Power.....	34
11.3	CV/CC Regulation .....	35
11.4	Power Factor and Total Harmonic Distortion .....	36
12	Thermal Performance.....	37
12.1	Operating Temperature Survey .....	37
13	Waveforms .....	38
13.1	Input Voltage and Current.....	38
13.2	LLC Resonating Capacitor Voltage and Current, Normal Operation.....	39
13.3	PFC Stage Voltage and Current – Normal Operation .....	39
13.4	AC Input Current and PFC Output Voltage - Startup .....	40
13.5	LLC Startup .....	40
13.6	Output Voltage during Startup and Shutdown .....	41
13.6.1	LLC Output .....	41
13.7	Output Ripple Measurements .....	42
13.7.1	Ripple Measurement Technique.....	42
13.7.2	24V Ripple Measurement Results .....	43
14	Conducted EMI .....	44
15	Revision History .....	46

**Important Note:**

Although this board is designed to satisfy safety isolation requirements, the engineering prototype has not been agency approved. Therefore, all testing should be performed using an isolation transformer to provide the AC input to the prototype board.

## 2 Introduction

This engineering report describes a 414 W extended European-input power supply for Lead Battery Charger applications. This reference design is based on the PLC810.

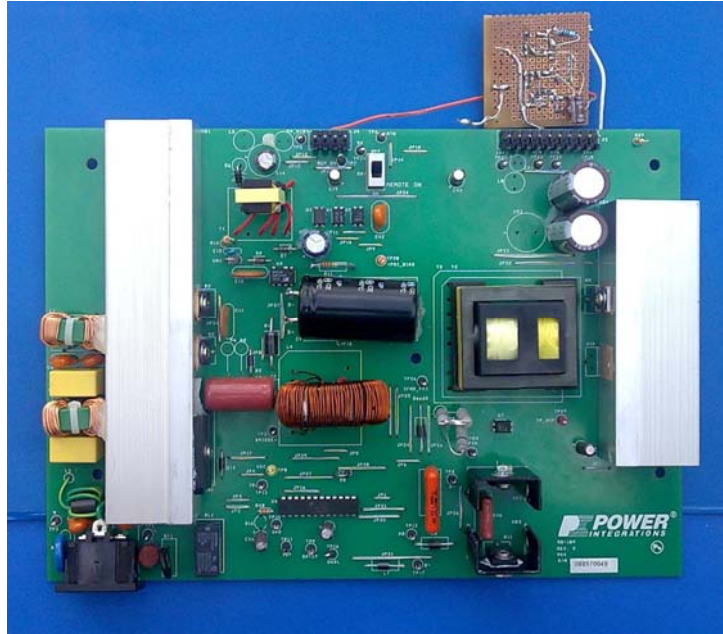


Figure 1 – Lead Battery Charger Board Top.

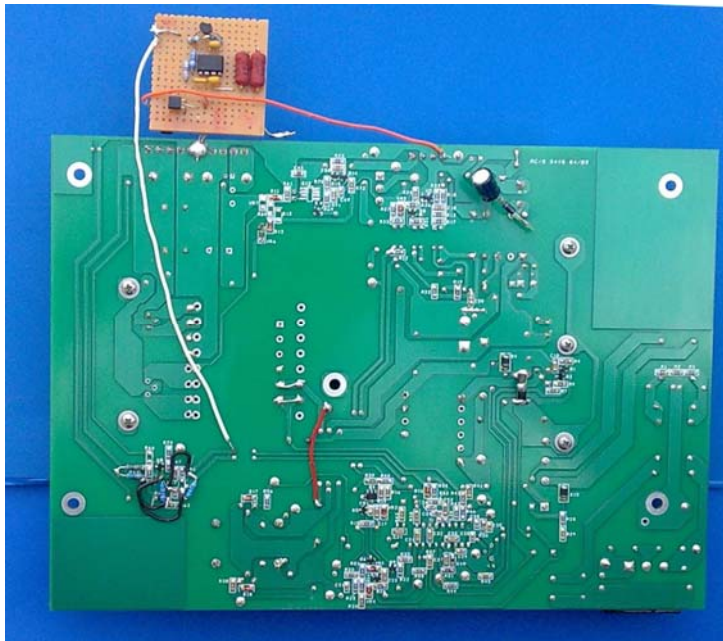


Figure 2– Lead Battery Charger Board Bottom

### 3 Power Supply Specification

Description	Symbol	Min	Typ	Max	Units	Comment
<b>Input</b>						
Voltage	$V_{IN}$	140		290	VAC	3 wire input
Frequency	$f_{LINE}$	47	50/60	64	Hz	
Power Factor	PF	0.95				Full Load, 230 VAC
No-load Input Power (230 VAC)				250	mW	Remote off, no load condition,
Available Standby Output Power	$P_{IN(1W)}$		0.5		W	For 1 W input power at 230 VAC
<b>Auxiliary Outputs</b>						
Standby Output Voltage	$V_{aux1}$		5		V	± 5%
Standby Output Ripple Voltage	$V_{RIPPLE(aux1)}$			50	mV	20 MHz bandwidth
Standby Output Current	$I_{OUT(aux1)}$		0.2		A	
Standby Output Voltage	$V_{aux2}$		12		V	± 15%
Standby Output Ripple Voltage	$V_{RIPPLE(aux2)}$			50	mV	20 MHz bandwidth
Standby Output Current	$I_{OUT(aux2)}$		0.3		A	
<b>Main Converter Output</b>						
Output Voltage	$V_o$		41.4		V	+/-5%
Output Ripple	$V_{RIPPLE}$			400	mV	20 MHz bandwidth
Output Current	$I_o$		10		A	+/-10%
<b>Total Output Power</b>						
Continuous Output Power	$P_{OUT}$	418			W	Auxiliary + Main
<b>Efficiency</b>						
Main at Full Load	$\eta_{Main}$		92		%	Measured at 230 VAC
<b>Environmental</b>						
Conducted EMI						Meets CISPR22B / EN55022B
Safety						Designed to meet IEC950 / UL1950 Class II
Surge						1.2/50 $\mu$ s surge, IEC 1000-4-5,
Differential		2			kV	Differential Mode: 2 $\Omega$
Common Mode		4			kV	Common Mode: 12 $\Omega$
100 kHz Ring Wave		4			kV	500 A short circuit current
Ambient Temperature	$T_{AMB}$	0		50	$^{\circ}$ C	Free convection, sea level, long side of board is oriented vertically, AC inlet on bottom edge

### 4 Schematic

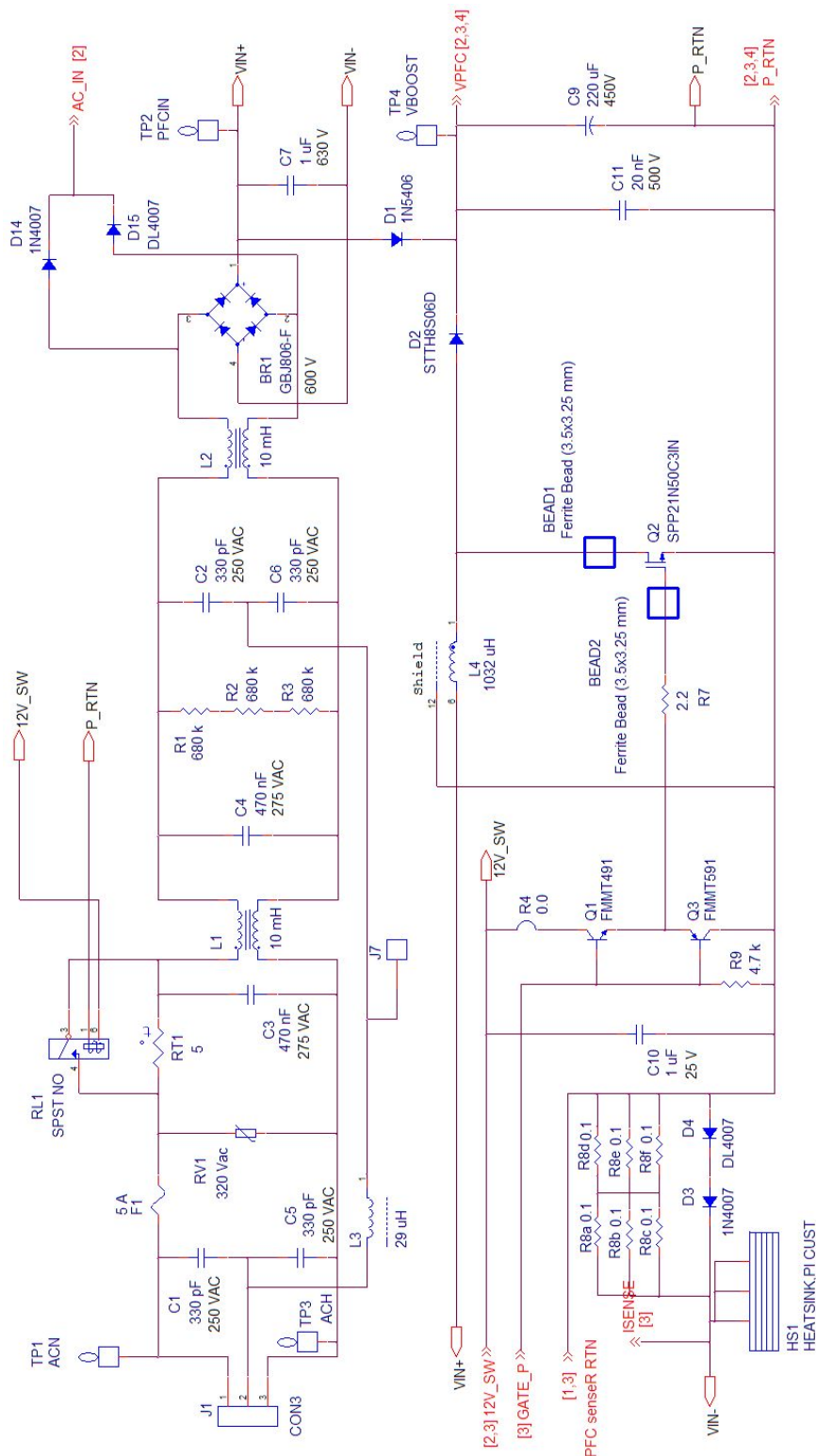


Figure 3 – Input/Boost Schematic

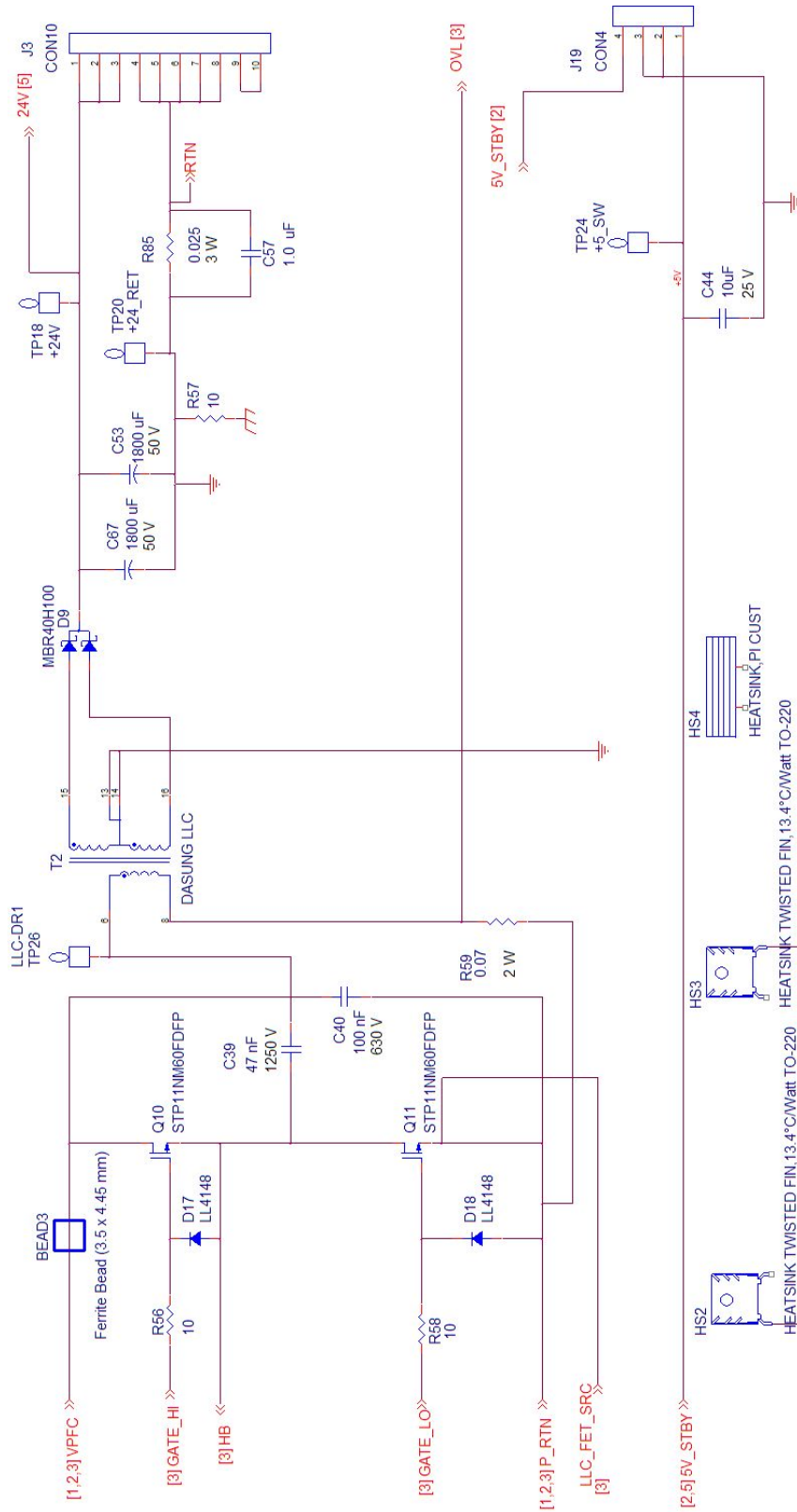


Figure 4 – LLC Schematic

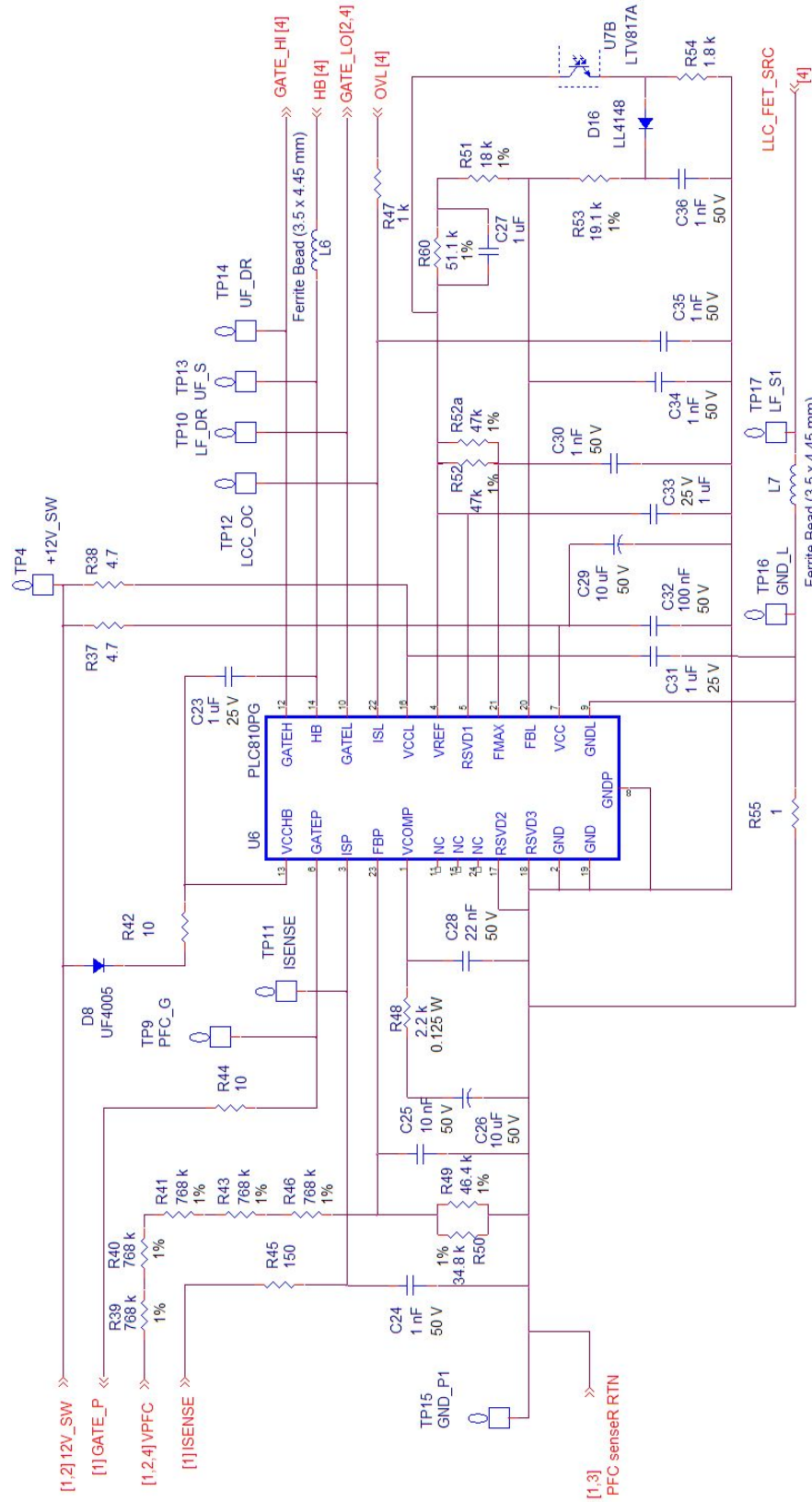


Figure 5 – Controller Circuit Schematic







## 5 Circuit Description

This circuit uses the PLC810 in a primary-side PFC + LLC configuration.

### 5.1 Input Filter/Boost Converter

The schematic in Figure 3 shows the input RFI filter and main PFC stage.

#### 5.1.1 EMI Filtering

Capacitors C1 and C5 are connected directly across the pins of input receptacle J1 and are used to control common mode noise at frequencies greater than 30MHz. A 5-turn ferrite bead inductor (L3) is used to connect the safety ground from J1 to chassis ground, providing damping at frequencies >30MHz. Common mode inductors L1 and L2 control EMI at low frequencies and the mid-band (~10 MHz), respectively. Capacitors C2 and C6 control resonant peaks in the mid-band (~10 MHz) region.

PFC inductor L4 has a grounded shield band to prevent electrostatic and magnetic noise coupling to the EMI filter components. Capacitors C3 and C4 provide differential mode EMI filtering. To meet safety requirements resistors R1, R2 and R3 discharge these capacitors when AC is removed. The heat sink for PFC switch FET Q2 and PFC output diode D2 is tied to primary return at the cathode of D3 to eliminate the heat sink as a source of radiated noise.

#### 5.1.2 Inrush limiting

Thermistor RT1 provides inrush limiting. It is shorted by a relay (RL1) gated by the power supply remote on signal, increasing efficiency by approximately 1-1.5%.

#### 5.1.3 Main PFC Stage.

Components C9, C11, L4, Q2, and D2 form a continuous mode power factor correction circuit. Components Q1, Q3, R4, R9 and bead 2 buffer the PWM drive signal for Q2 from the PLC810 controller. Resistor R4 allows the turn-on speed and R7 the turn-off speed of Q2 to be adjusted to optimize the losses between D2 and Q2. In this design it was found that efficiency and EMI were both improved by reducing the value of R4 and R7 and adding ferrite beads to the gate and drain of Q2 (bead 2 and bead 1 respectively). In general, increasing MOSFET turn on drive current reduces MOSFET switching losses but increases the reverse recovery current through D2 and associated ringing. An ultra fast diode was selected for D2 as a lower cost alternative to a silicon carbide or other proprietary diode technology. These may provide higher efficiency by reducing reverse recovery charge, but significantly increase solution cost.

### 5.2 Main LLC Output

The Figure 4 schematic shows the LLC converter stage.

### 5.2.1 LLC Input Stage

MOSFETs Q10 and Q11 are the switch MOSFETs for the LLC converter. They are driven directly by the controller IC via resistors R56 and R58. Capacitor C39 is the primary resonating capacitor, and should be a low-loss type rated for the RMS current at maximum load. Capacitor C40 is used for local bypassing, and is positioned adjacent to Q10 and Q11. Resistor R59 provides primary current sensing to the controller for overpower protection.

### 5.2.2 LLC Output

The secondaries of transformer T2 are rectified and filtered by D9, C53 for the 13.8V output. No inductive filters are needed. Resistor R57 is connected between secondary return and chassis ground for high frequency EMI damping, as well as to tie the secondary return to chassis ground.

## 5.3 Controller

Figure 5 shows the circuitry around the U6 main controller IC, which provides control functions for the input PFC and output LLC stages.

### 5.3.1 PFC Control

The PFC boost stage output voltage is fed back to the boost voltage sense pin (FBP of U6) via resistors R39-41, R43, R46, and R50, R49. Capacitor C25 filters noise. Components C26, C28 and R48 provide frequency compensation for the PFC. The PFC current sense signal from resistors R8 is filtered by R45 and C24. The PFC drive signal from the GATEP pin is routed to the main switching FET via R44. This damps any ringing in the PFC drive signal caused by the trace length from U6 to PFC switch MOSFET Q2.

### 5.3.2 Bypassing/Ground Isolation

Capacitors C29, C31, and C32 provide supply bypassing for the analog and digital supply rails for U6. Resistor R55 and ferrite bead L7 provide ground isolation between the PFC and LLC ground systems. Resistors R37 and R38 isolate the IC analog and digital supply rails. Ferrite bead L6 provides high frequency isolation between the LLC stage high side MOSFET drive return and the controller IC.

### 5.3.3 LLC Control

Feedback from the LLC output sense/feedback circuit is provided by U7, which develops a feedback voltage across resistor R54. Capacitor C36 filters the feedback signal. Resistors R49, R51, and R53 set the lower frequency limit for the LLC converter stage. Capacitor C27 is used to provide output soft start. Resistor R52, R36 set the LLC upper frequency limit. Capacitor C30 is a noise filter. The LLC overload sense signal from resistor R59 is filtered by R47 and C35. Components C23, R42, and D8 provide bootstrapping for the LLC top side MOSFET drive.

## **5.4 LLC Secondary Control Circuits**

Figure 6 shows the secondary control schematic for the LLC stage.

### **5.4.1 Voltage and Current Feedback**

The LLC converter 13.8V output is sensed, by voltage divider R66, R68 driving the shunt reference U8. Optocoupler U7 is transferring the feedback signal to primary side.

Resistors R72, R73. VR7 and D13 sense any overvoltage condition. The overvoltage signal is used to trigger a bipolar latch (Q14, Q15, R70, R73), which turns on transistor Q13. This transistor is used to deactivate the remote-on circuit (Figure 5), which turns off the primary bias, and hence the main controller IC.

The output current is sensed by resistor R85 . The voltage drop across this resistor is then compared by U10 against a reference voltage created by U9, and R75, R76. This creates a 10A constant current output.

## **5.5 Flyback Power Supply**

The schematic in Figure 7 shows the flyback standby and bias supply implemented using a TNY274PN. It is a dual output power supply with a +5V and a +12V output. The +5V output is meant to supply a  $\mu$ Controller, the +12V output is meant to drive a small DC fan.

It also provides a primary referenced output used to supply the power for the PLC810PG controller IC. The schematic also shows the primary bias regulator, remote start, and brown-in/brown-out protection circuits.

### **5.5.1 5V/12V Flyback Supply**

Components VR1, R10, C12, and D5 clamp the primary leakage spike. This Zener-type clamp was selected over a RCD type for low standby power consumption. Resistor R11-R119 set the standby supply turn-on threshold to approximately 110 VAC. Components VR5, U2, R27, and R33 are used for overvoltage shutdown protection during an open loop fault condition. Components U3, U5, R13, R17, R18, R23, C18 and C19 are the secondary output sensing and feedback components.

Capacitor C13 is used for local primary bypassing for the flyback converter. Resistor R12 provides sufficient bias to U3 to turn off its internal HV bias supply, reducing low load and no-load power consumption. Capacitor C42 reduces common mode EMI.

### **5.5.2 Primary Bias regulator/Remote Start**

Components Q4, Q5, Q6, VR2, U1, C17, C51 R14, R16, R20, and SW1 constitute the bias regulator and remote on-off functions. Darlington transistor Q4, R14, and VR2 form a simple emitter-follower voltage regulator that is switched via optocoupler U1. Capacitor C17 limits the rate of rise of the bias voltage to avoid triggering the current limit of the standby supply. Components Q5, C51, and R20 quickly discharge C17 when optocoupler U1 is turned off.

Optocoupler U1 is turned on and off by Q8, SW1, R34, and R36. The supply can also be turned on by shorting test points TP5 and TP7.

### 5.5.3 Brownout Shutdown Circuit

A brownout shutdown circuit is provided. This circuit operates by sensing the AC input voltage and the presence of a switching signal from the LLC controller. When the power supply is operating, the absence of both of these signals, indicating insufficient AC input voltage and insufficient B+ voltage at the input to the LLC converter stage will cause the supply to shut down by switching off the primary bias regulator.

Components R24, R26, R28-30, C21, VR4, and Q7 are used to sense The AC input voltage. The voltage threshold of this circuit is set below the turn-on threshold of the standby/primary bias converter. Sufficient AC voltage triggers Q7, discharging capacitor C22, which is charged via R15. Resistor R25 provides some hysteresis to prevent chattering around the AC threshold voltage. Components R32, R35, and Q9 sense the switching drive from the lower output FET of the LLC converter. Transistor Q9 discharges capacitor C22 when the switching signal is present.

When the input voltage is sufficiently low, Q7 and Q9 turn off, allowing C22 to charge. Components Q6, R21, and VR3 sense the voltage at C22. When C22 has charged sufficiently, Q6 turns on, turning off the primary bias supply via Q4 and Q5, shutting down the PFC and LLC stages.

### PCB Layout

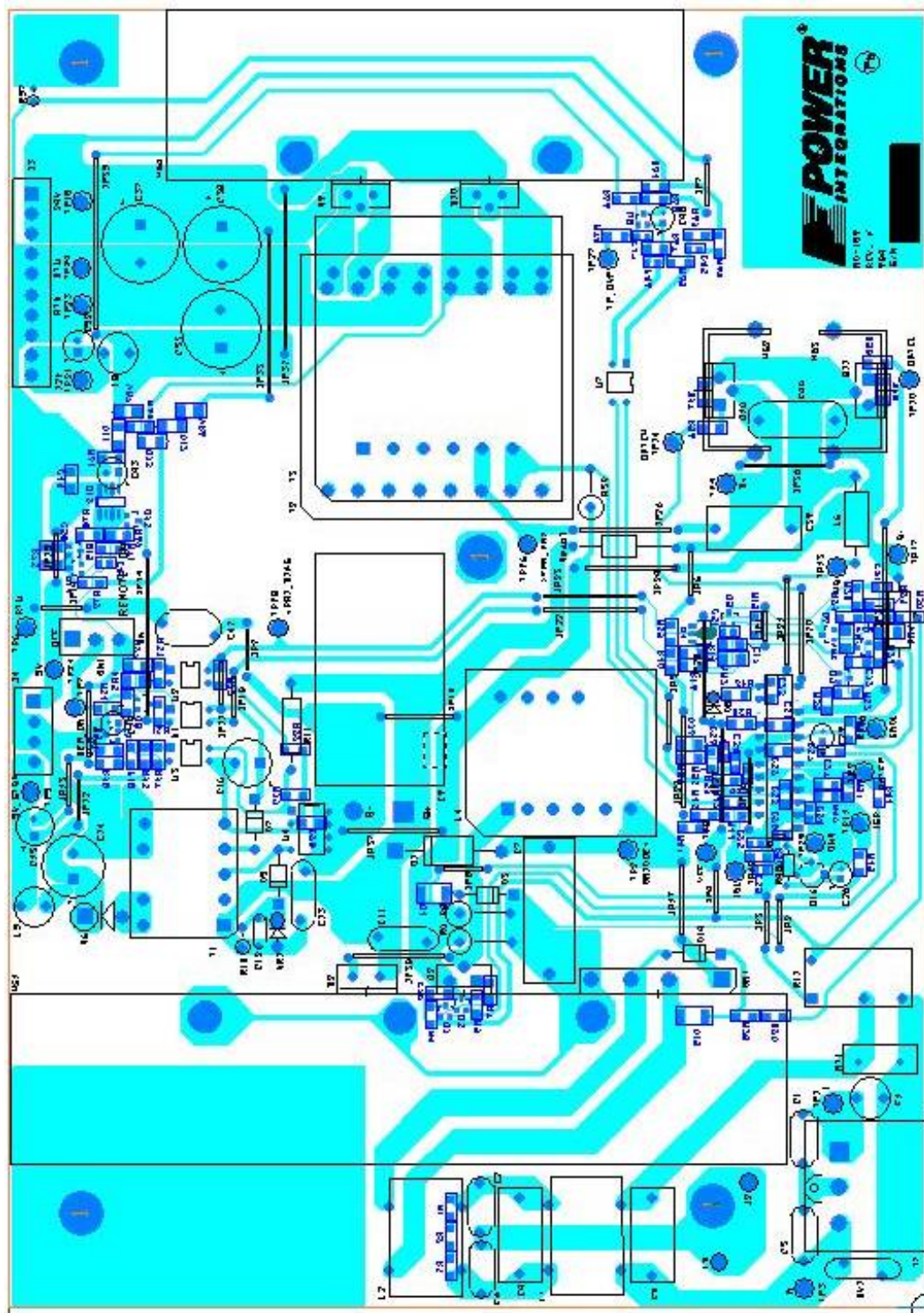


Figure 8 – Printed Circuit Layout.

## 6 Bill of Materials

Item	Qty	Part Reference	Description	Mfg Part Number	Mfg
1	2	BEAD1 BEAD2	3.5 mm D x 3.25 L mm, 21 Ohms at 25 MHz, 1.6mm (.063) hole, Ferrite Bead	2643001501	Fair-Rite
2	3	BEAD3 L6 L7	3.5 mm x 4.45 mm, 68 Ohms at 100 MHz, 22 AWG hole, Ferrite Bead	2743001112	Fair-Rite
3	1	BR1	600 V, 8 A, Bridge Rectifier, GBJ Package	GBJ806-F	Diodes Inc
4	4	C1 C2 C5 C6	330 pF, Ceramic Y1	440LT33-R	Vishay
5	2	C3 C4	470 nF, 275 VAC, Film, X2	PX474K31D5	Carli
6	1	C7	1 uF, 630 V, Polypropylene Film	ECW-F6105HL	Panasonic
7	1	C8	220 uF, 16 V, Electrolytic, Low ESR		
8	1	C9	220 uF, 450 V, Electrolytic, (25 x 45)	ECO-S2WP221CX	Panasonic
9	6	C10 C17 C23 C27 C31 C33	1 uF, 25 V, Ceramic, X7R, 1206	ECJ-3YB1E105K	Panasonic
10	2	C11 C13	20 nF, 500 V, Disc Ceramic	D203Z59Z5UL63L0R	Vishay/BC
11	1	C12	1 nF, 1 kV, Disc Ceramic	DEBE33A102ZC1B	Murata
13	1	C14	220 uF, 10 V, Electrolytic, Very Low ESR		
14	1	C16	470 uF, 35 V, Electrolytic, Low ESR, 52 mOhm, (10 x 20)	ELXZ350ELL471MJ20S	Nippon Chemi-Con
15	4	C18 C20 C22 C32	100 nF, 50 V, Ceramic, X7R, 1206	ECJ-3VB1H104K	Panasonic
16	3	C19 C26 C29	10 uF, 50 V, Electrolytic, Gen. Purpose, (5 x 11)	EKMG500ELL100ME11D	Nippon Chemi-Con
17	6	C21 C24 C30 C34 C35 C36	1 nF, 50 V, Ceramic, X7R, 0805	ECJ-2VB1H102K	Panasonic
18	2	C25 C49	10 nF, 50 V, Ceramic, X7R, 0805	ECJ-2VB1H103K	Panasonic
19	3	C28 C45 C47	22 nF, 50 V, Ceramic, X7R, 0805	ECJ-2VB1H223K	Panasonic
20	1	C39	47 nF, 630 V, Film	BFC2 375 14473	Vishay
21	1	C40	100 nF, 630 V, Film	ECQ-E6104KF	Panasonic
22	1	C42	1 nF, Ceramic, Y1	440LD10-R	Vishay
23	1	C44	10 uF, 25 V, Ceramic, X7R, 1206	ECJ-3YB1E106M	Panasonic
24	1	C46	2.2 nF, 50 V, Ceramic, X7R, 0805	ECJ-2VB1H222K	Panasonic



25	2	C67 C53	1800 uF, 50 V, Electrolytic, Very Low ESR	KY series	Nippon Chemi-Con
26	1	C48	1 uF, 50 V, Electrolytic, Gen. Purpose, (5 x 11)	EKMG500ELL1R0ME11D	Nippon Chemi-Con
27	1	C50	220 nF, 25 V, Ceramic, X7R, 1206	ECJ-3VB1E224K	Panasonic
28	1	C51	100 pF, 100 V, Ceramic, COG, 0805	C0805C101J1GACTU	Kemet
29	1	C54	100 nF, 50 V, Ceramic, X7R	B37987F5104K000	Epcos
30	2	C55 C57	1.0 uF, 50 V, Ceramic, X7R	B37984M5105K000	Epcos
31	1	D1	600 V, 3 A, Rectifier, DO-201AD	1N5406	Vishay
32	1	D2	600 V, 8 A, Ultrafast Recovery, 12 ns, TO-220AC	STTH8S06D	ST Semiconductor
33	2	D3 D14	1000 V, 1 A, Rectifier, DO-41	1N4007-E3/54	Vishay
34	2	D4 D15	1000 V, 1 A, Rectifier, Glass Passivated, DO-213AA (MELF)	DL4007-13-F	Diodes Inc
35	1	D5	1000 V, 1 A, Ultrafast Recovery, 75 ns, DO-41	UF4007-E3	Vishay
36	3	D6 D7 D10	200 V, 1 A, Ultrafast Recovery, 50 ns, DO-41	UF4003-E3	Vishay
37	1	D8	600 V, 1 A, Ultrafast Recovery, 75 ns, DO-41	UF4005-E3	Vishay
38	1	D9	100 V, 40 A, Dual Schottky, TO-220AB	MBR40H100	Onsemi
39	4	D12 D16 D17 D18	75 V, 0.15 A, Fast Switching, 4 ns, MELF	LL4148-13	Diode Inc.
40	1	F1	5 A, 250V, Slow, TR5	3721500041	Wickman
41	1	GREASE1	Thermal Grease, Silicone, 5 oz Tube	CT40-5	ITW Chemtronics
42	4	HS PAD1 HS PAD2 HS PAD3 HS PAD4	HEATSINK PAD, TO-220, Sil-Pad K10	K10-58	Bergquist
43	1	HS1	HEATSINK, Alum, EXT, 3 hole, 3 mtg holes, 6.00" L x 1.150" W x 1.300" H	62230U06000G,MOD	Aavid
44	2	HS2 HS3	HEATSINK, TWISTED FIN, 13.4°C/Watt, TO-220	593002B03400G	AavidThermalloy
45	1	HS4	HEATSINK, Alum, EXT, 2 hole, 2 mtg holes, 4.00" L x 1.150" W x 1.300" H	62230U04000G,MOD	Aavid

46	1	J1	AC Input Receptacle and Accessory Plug, PCBM	161-R301SN13	Kobiconn
47	1	J3	10 Position (1 x 10) header, 0.156 pitch, Vertical	26-48-1105	Molex
48	1	J4	4 Position (1 x 4) header, 0.156 pitch, Vertical	26-48-1045	Molex
49	2	L1 L2	Common Mode Choke Toroidal	P/N T22148-902S (Order PI Taiwan)	Fontaine Tech CO. LTD
50	1	L3	29 uH, Ground Choke, Flying Lead		
51	1	L4	PFC Choke, Toroidal Core, 1032 mH		
52	4	MTG_HOLE2 MTG_HOLE3 MTG_HOLE4 MTG_HOLE5	Mounting Hole No 6		
53	2	NUT1 NUT2	Nut, Hex, Kep 4-40, S ZN Cr3 plateing RoHS	4CKNTZR	Olander
54	1	Q1	NPN,60V 1000MA, SOT-23	FMMT491TA	Zetex Inc
55	1	Q2	560 V, 21 A, 190 mOhm. N-Channel, TO-220	SPP21N50C3	Infineon
56	1	Q3	PNP, 60V 1000MA, SOT-23	FMMT591TA	Zetex Inc
57	1	Q4	NPN, DARL 80V 500MA, SOT-89	BST52TA	Zetex Inc
58	3	Q5 Q13 Q14	PNP, Small Signal BJT, 40 V, 0.2 A, SOT-23	MMBT3906LT1G	On Semiconductor
59	5	Q6 Q7 Q8 Q9 Q15	NPN, Small Signal BJT, 40 V, 0.2 A, SOT-23	MMBT3904LT1G	On Semiconductor
60	2	Q10 Q11	600 V, 11 A,370 mOhm. N-Channel, TO-220F	STP11NM60FDFP	IR/Vishay
61	1	Q17	NPN, Small Signal BJT, 40 V, 0.2 A, TO-92	2N3904RLRAG	On Semiconductor
62	5	R1 R2 R3 R29 R30	680 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ684V	Panasonic
63	1	R4	0 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEY0R00V	Panasonic
64	1	R7	2.2 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ2R2V	Panasonic
65	6	R8a R8b R8c R8d R8e R8f	0.1 R, 1%, 1/2 W, Metal Film		Panasonic
66	1	R9	4.7 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ472V	Panasonic
67	1	R10	220 k, 5%, 1/2 W, Carbon Film	CFR-50JB-220K	Yageo
68	1	R11	4.7 M, 5%, 1/4 W,	CFR-25JB-4M7	Yageo

			Carbon Film		
69	3	R12 R14 R16	22 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ223V	Panasonic
70	2	R13 R22	470 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ471V	Panasonic
71	1	R15	330 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ334V	Panasonic
72	8	R17 R33 R36 R47 R63 R65 R72 R77	1 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ102V	Panasonic
73	1	R18	10.2 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF1022V	Panasonic
74	1	R19	1.3 M, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ135V	Panasonic
75	1	R20	220 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ224V	Panasonic
76	2	R21 R26	100 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ104V	Panasonic
77	1	R23	10.0 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF1002V	Panasonic
78	1	R24	226 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF2263V	Panasonic
79	1	R25	3.9 M, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ395V	Panasonic
80	1	R27	33 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ330V	Panasonic
81	1	R28	620 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ624V	Panasonic
82	1	R31	2.2 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ222V	Panasonic
83	6	R32 R35 R69 R70 R73 R74	10 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ103V	Panasonic
84	1	R34	3.9 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ392V	Panasonic
85	2	R52 R52a	47 k, 1%, 1/8 W, Metal Film, 0805		
86	2	R37 R38	4.7 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ4R7V	Panasonic
87	5	R39 R40 R41 R43 R46	768 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF7683V	Panasonic
88	4	R42 R44 R56 R58	10 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ100V	Panasonic
89	1	R45	150 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ151V	Panasonic
90	1	R48	2.2 k, 5%, 1/8 W, Carbon Film	CFR-12JB-2K2	Yageo
91	1	R60	51.1 k, 1%, 1/4 W, Metal Film, 1206		Panasonic
92	1	R49	46.4 k, 1%, 1/4 W, Metal Film, 1206		Panasonic
93	1	R50	34.8 k, 1%, 1/4 W, Metal Film, 1206		Panasonic
94	1	R51	18 k, 1%, 1/8 W, Metal Film, 0805		Panasonic

95	1	R53	19.1 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF1912V	Panasonic
96	1	R54	1.8 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ182V	Panasonic
97	1	R55	1 R, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ1R0V	Panasonic
98	1	R57	10 R, 5%, 1/4 W, Carbon Film	CFR-25JB-10R	Yageo
99	1	R59	CURRENT SENSE 0.07 OHM 2W		Ohmite
100	1	R62	6.8 k, 5%, 1/4 W, Metal Film, 1206		
101	1	R66	150 k, 1%, 1/4 W, Metal Film, 1206		
102	1	R67	470 k, 5%, 1/4 W, Metal Film, 1206	ERJ-8GEYJ474V	Panasonic
103	1	R68	10 k, 1%, 1/8 W, Metal Film, 0805	ERJ-6ENF1002V	Panasonic
104	1	R71	100 R, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF1000V	Panasonic
105	1	R75	249 R, 1%, 1/4 W, Metal Film	MFR-25FBF-249R	Yageo
106	1	R76	2.26 k, 1%, 1/4 W, Metal Film	MFR-25FBF-2K26	Yageo
107	1	R77	1 k, 5%, 1/8 W, Carbon Film	CFR-12JB-1K2	Yageo
108	2	R78	3.3 k, 5%, 1/4 W, Carbon Film	CFR-25JB-3K3	Yageo
109	1	R79	3.9 k, 5%, 1/4 W, Carbon Film	CFR-25JB-3K9	Yageo
110	1	R80	1.6 k, 5%, 1/4 W, Carbon Film	CFR-25JB-1K6	Yageo
111	1	R81	30 R, 5%, 1/4 W, Carbon Film	CFR-25JB-30R	Yageo
112	1	R82	51 R, 5%, 1/4 W, Carbon Film	CFR-25JB-51R	Yageo
112	1	R85	CURRENT SENSE .025 OHM 3W		Ohmite
113	1	R86	5.6 k, 1%, 1/4 W, Metal Film, 1206	ERJ-8ENF562V	Panasonic
114	1	R119	2.2 M, 5%, 1/4 W, Carbon Film	CFR-25JB-2M2	Yageo
115	1	RL1	SPST-NO, 5A 12VDC, PC MNT	G6B-1114P-US-DC12	OMRON
116	1	RT1	NTC Thermistor, 5 Ohms, 4.7 A	CL150	Thermometrics
117	1	RV1	320V, 84J, 15.5 mm, RADIAL	S14K320	Epcos
118	5	SCREW1 SCREW2 SCREW3 SCREW4 SCREW18	SCREW MACHINE PHIL 6-32X5/16 SS	PMSSS 632 0031 PH	Building Fasteners

119	12	SCREW5 SCREW6 SCREW7 SCREW8 SCREW9 SCREW10 SCREW11 SCREW12 SCREW13 SCREW14 SCREW15 SCREW16	SCREW MACHINE PHIL 4-40X5/16 SS	PMSSS 440 0031 PH	Building Fasteners
120	5	STDOFF1 STDOFF2 STDOFF3 STDOFF4 STDOFF5	Standoff Hex,6-32, .375L,Alum	2209	Keystone Elect
121	1	SW1	SLIDE MINI SPDT PC MNT AU	1101M2S3CBE2	ITT Ind/C&Kdiv
122	1	T1	EE16 Custom Transformer		
123	1	T2	Dasung custom Transformer, ER3944		Dasung Magnetics
124	21	TP1 TP2 TP3 TP4 TP5 TP6 TP7 TP9 TP10 TP11 TP12 TP13 TP14 TP15 TP16 TP17 TP18 TP20 TP24 TP26 TP29	Test Point, BLK,THRU- HOLE MOUNT	5011	Keystone
125	1	TP8	Test Point, YEL,THRU- HOLE MOUNT	5014	Keystone
126	1	TP27	Test Point, RED,THRU- HOLE MOUNT	5010	Keystone
127	1	TP28	Test Point, ORG,THRU- HOLE MOUNT	5013	Keystone
128	1	U10	DUAL Op Amp, Single Supply, DIP-8	LM358P	Texas Instruments
129	3	U1 U2 U7	Opto coupler, 35 V, CTR 80-160%, 4-DIP	LTV-817A	Liteon
130	1	U4	TinySwitch-III, TNY274PN, DIP-8C	TNY274PN	Power Integrations
131	1	U3	Opto coupler, 80 V, CTR 300-600%, 4-DIP	PC817X4J000F	Sharp
132	2	U5 U8	IC, REG ZENER SHUNT ADJ SOT-23	LM431AIM3/NOPB	National Semiconductor
133	1	U6	Controller, PFC/LLC, 24-pin DIP	PLC810PG	Powerintegrations
134	1	U9	2.495 V Shunt Regulator IC, 2%, 0 to 70C, TO-92	TL431CLPG	On Semiconductor
135	1	VR1	150 V, 5 W, 5%, TVS, DO204AC (DO-15)	P6KE150A	LittleFuse

136	2	VR2	15 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5245B-7	Diodes Inc
137	1	VR3	5.6 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5232B-7	Diodes Inc
138	1	VR4	10 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5240B-7	Diodes Inc
139	1	VR5	5.1 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5256B-7	Diodes Inc
140	1	VR6	30 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5248B-7	Diodes Inc
141	1	VR7	18 V, 5%, 500 mW, DO-213AA (MELF)	ZMM5231B-7	Diodes Inc
142	5	WASHER1 WASHER2 WASHER3 WASHER4 WASHER18	Washer Flat #6, SS	FWSS 006	Building Fasteners
143	12	WASHER5 WASHER6 WASHER7 WASHER8 WASHER9 WASHER10 WASHER11 WASHER12 WASHER13 WASHER14 WASHER15 WASHER16	WASHER FLAT #4 SS	FWSS 004	Building Fasteners
144	4	WASHER17 WASHER18 WASHER19 WASHER20	Washer Nylon Shoulder #4	3049	Keystone

## 7 Main LLC Transformer (T2) Specification

### 7.1 Electrical Diagram

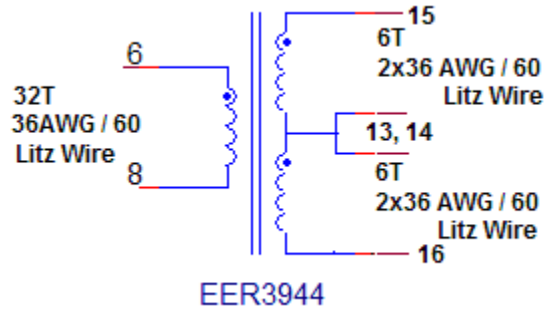


Figure 9 – Transformer Electrical Diagram.

### 7.2 Electrical Specifications

<b>Electrical Strength</b>	1 second, 60Hz, from Pins 1-9 to Pins 10-18	3000VAC
<b>Primary Inductance</b>	Pin 6-8 , all other windings open, measured at 94.4 KHz, 0.4 VRMS	260 uH, +/- 10%
<b>Primary Leakage Inductance</b>	Pins 13-14, with Pins 15- 16 shorted, , measured at 94.4 KHz, 0.4 VRMS	60 uH (typ)

## 8 Flyback Transformer (T1)

### 8.1 Electrical Diagram

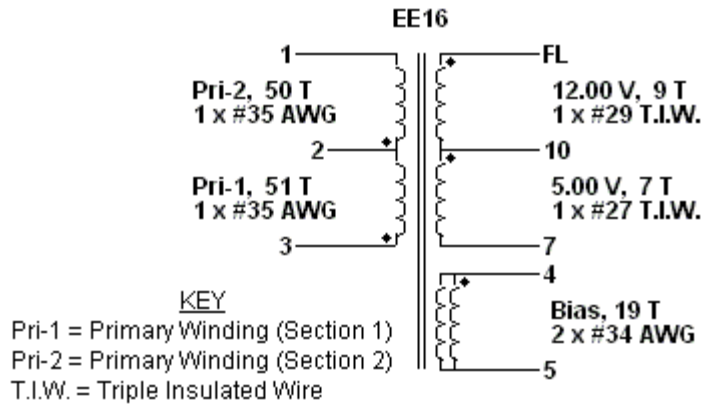


Figure10– Standby Transformer Schematic

### 8.2 Electrical Specifications

<b>Electrical Strength</b>	60 Hz 1 second, from pins 1,2,3,4,5 to pins 7,10.	3000VAC
<b>Primary Inductance</b>	Pin 1-3 , all other winding open, measured at typical switching frequency, 0.4 VRMS	2154 uH, +/- 10%
<b>Primary Leakage Inductance</b>	Measured between Pin 1 to Pin 3, with all other Windings shorted.	54 μH (max)

### 8.3 Materials

Item	Description
[1]	Core: EE16, NC-2H (Nicer) or Equivalent, gapped for ALG of 212 nH/t <sup>2</sup>
[2]	Bobbin: Generic, 5 pri. + 5 sec.
[3]	Barrier Tape: Polyester film (1 mil base thickness), 8.60 mm wide
[4]	Varnish
[5]	Magnet Wire: 35 AWG, Solderable Double Coated
[6]	Magnet Wire: 34 AWG, Solderable Double Coated
[7]	Triple Insulated Wire: 27 AWG
[8]	Triple Insulated Wire: 29 AWG

### 8.4 Build Diagram



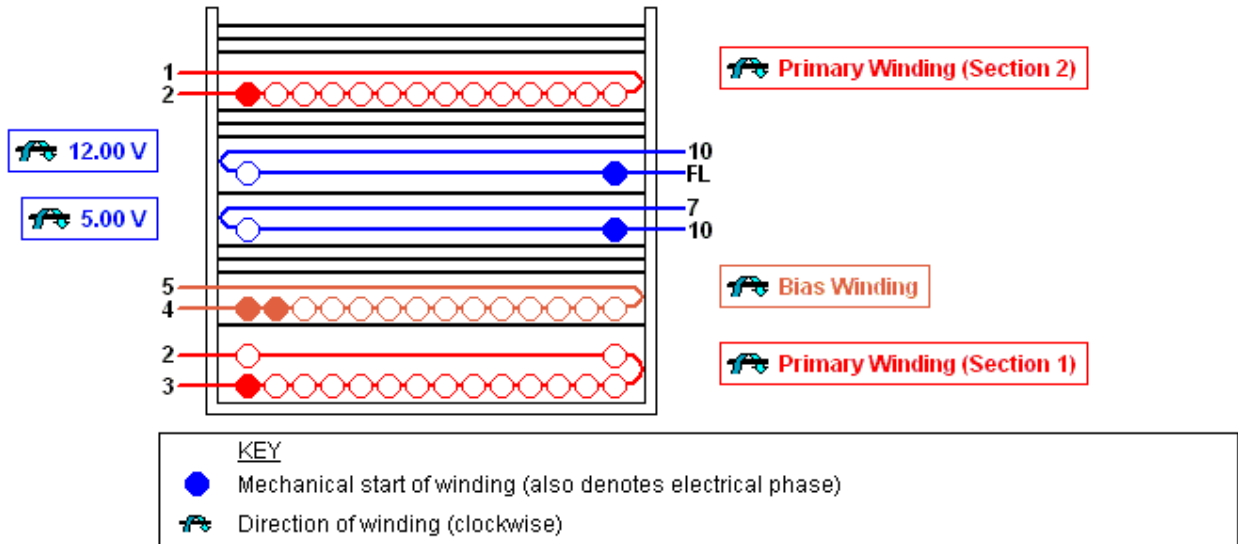


Figure 11 – Standby Transformer Build Diagram

8.5 Construction

<b>Winding preparation</b>	Orient bobbin (item [2]) on winding machine such that the primary pin side of bobbin (pins 1-5) is on the left side.
<b>WD1 (1<sup>st</sup> half Primary)</b>	Start on pin(s) 3 and wind 51 turns (x 1 filar) of item [5] in 2 layer(s) from left to right. At the end of 1st layer, continue to wind the next layer from right to left. On the final layer, spread the winding evenly across entire bobbin. Finish this winding on pin(s) 2.
<b>Insulation</b>	Apply one layer of tape (item [7]).
<b>WD2 (Bias)</b>	Start on pin(s) 4 and wind 19 turns (x 2 filar) of item [6]. Wind in same rotational direction as primary winding. Spread the winding evenly across entire bobbin. Finish this winding on pin(s) 5.
<b>Insulation</b>	Apply three layers of tape (item [6]).
<b>WD3 (Secondary)</b>	Start on pin(s) 10 and wind 7 turns (x 1 filar) of item [7]. Spread the winding evenly across entire bobbin. Wind in same rotational direction as primary winding. Finish this winding on pin(s) 7.
<b>Insulation</b>	Apply one layers of tape (item [6]).
<b>WD4 (Secondary)</b>	Start on pin(s) FL and wind 9 turns (x 1 filar) of item [8]. Spread the winding evenly across entire bobbin. Wind in same rotational direction as primary winding. Finish this winding on pin(s) 10.
<b>Insulation</b>	Apply three layer of tape (item [6]).
<b>WD1 (2<sup>nd</sup> half Primary)</b>	Start on pin(s) 2 and wind 50 turns (x 1 filar) of item [5] in 1 layer(s) from left to right. At the end of 1st layer, continue to wind the next layer from right to left. On the final layer, spread the winding evenly across entire bobbin. Finish this winding on pin(s) 1.
<b>Insulation</b>	Apply 3 layers of tape (item [6]) as finish wrap.
<b>Finish</b>	Gap core halves (item [1]) for inductance of 2154 uH +/-10%. Assemble and secure core halves. Dip varnish using (item [4]).

## 9 PFC Choke Specification (L4)

### 9.1 Electrical Diagram

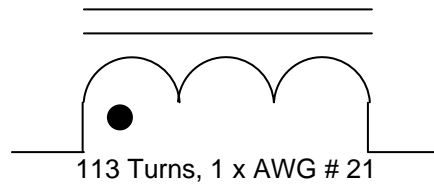


Figure 12 – PFC Choke schematic

### 9.2 Electrical Specification

Inductance: 1.032  $\mu$ H +/- 15%

### 9.3 Materials

Item	Description
[1]	Toroidal Core: Kool Mu, Magnetics 0077083A7
[2]	Magnet Wire: #21AWG, solderable double coated.
[3]	Tape Polyester Film, 3M 1350F-1, or equivalent.
[6]	Tie wrap Nylon 99mm Panduit PLT-IM or equivalent

### 9.4 Build Diagram

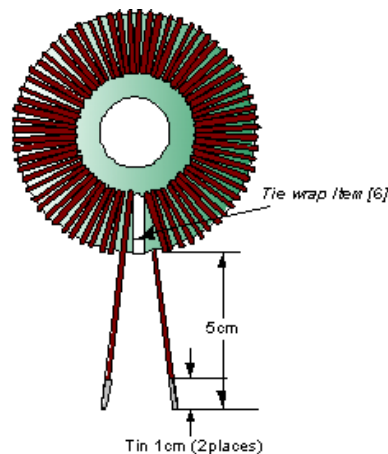


Figure 13 – PFC Choke Build Diagram

### **9.5 Winding Instructions**

1. Wind 113 turns of AWG # 21 wire in clockwise direction for first layer.
2. Completely fill the first layer before going into the second layer.
3. Make sure that the windings are evenly distributed for each layer.
4. Fix winding with tape.

### 10 LLC Spreadsheet

ACDC_PLC810_030509; Rev.1.3; Copyright Power Integrations 2008	INPUTS	INFO	OUTPUTS	UNITS	ACDC_PLC810_030509_Rev1-3.xls; PLC810 Half-Bridge, Continuous mode LLC Resonant Converter Design Spreadsheet
<b>Enter Input Parameters</b>					<b>Design Title</b>
Vacmin	140.00		140	V	Minimum AC input voltage
Vacmax	290.00		290	V	Maximum AC input voltage
Iacimmax			3.60	A	Maximum input AC rms current at Vacmin
Vbulk	420.00		420.00	V	Nominal PFC output voltage
Vbulkmax			449.40	V	Peak PFC OVP voltage (typical is 7% above Vbulk)
Vbulkmin	280.00		280.00	V	Minimum bulk capacitor voltage at the specified holdup time. Typical value is between 250 - 320 VDC. Max holdup time is at 250 V
fL	47.00		47.00	Hz	AC Line input frequency
Holdup time	10.00		10.00	ms	Bulk capacitor hold up time
CIN_MIN			93.55	uF	Minimum value of bulk cap to meet holdup time requirement; Adjust holdup time and Vbulkmin to change bulk cap value
bulk ripple			24.10	V	Bulk capacitor peak to peak voltage (low freq ripple)
Vrippeak			432.05	V	Bulk cap peak value of ripple voltage
IAC			3.60	A	AC input rms current at VACMIN
IAC_PEAK			5.09	A	Peak AC input current at full load and VACMIN
<b>Enter LLC (secondary) outputs</b>					The spreadsheet assumes AC stacking of the secondaries
Vo1	41.40			V	Main Output Voltage. Spreadsheet assumes that this is the regulated output
Io1	10.00			A	Main output maximum current
Vd1			0.70	V	Forward voltage of diode in main output
Po1			414.00	W	Output Power from first LLC output
Vo2				V	Second Output Voltage
Io2				A	Second output current
Vd2			0.70	V	Forward voltage of diode used in second output
Po2			0.00	W	Output Power from second LLC output
<b>Enter stand-by (auxiliary) outputs</b>					
Vo3	13.00			V	Auxiliary Output 1 Voltage
Io3	0.20			A	Auxiliary Output 1 maximum current
Vo4				V	Auxiliary Output 2 Voltage
Io4				A	Auxiliary Output 2 maximum current
<b>Efficiency and Loss Allocation</b>					
P_LL			414.00	W	Specified LLC output power
P_AUX			2.60	W	Auxiliary output power
P_PFC			458.41	W	PFC output power
P_TOTAL			416.60	W	Total output power (Includes Output power from LLC stage and auxiliary stage)
LLC_n_estimated	0.91		0.91		Efficiency of LLC stage
AUX_n_estimated			0.75		Efficiency of auxiliary output
PFC_n_estimated	0.91		0.91		Minimum efficiency of PFC front end stage
PIN			503.75	W	AC input power
Overall efficiency			0.83		Minimum system efficiency
Ploss_PFC			45.34	W	PFC stage power loss
Ploss_LL			40.95	W	LLC stage power loss
Ploss_AUX			0.87	W	Auxiliary power loss
Ploss_TOTAL			87.15	W	Total power loss

<b>Enter PFC Design Parameters</b>					
f_nominal_desired	94.40		94.40	kHz	Desired full load switching frequency. Recommended value 66 kHz to 132 kHz
Krp	0.43		0.43		PFC choke ripple current factor. Actual Krp tends to increase at higher current when using iron powder/Sendust cores, due to drop in inductance at higher current
Diode bridge Vf			0.70	V	Forward voltage drop of diode bridge
Rdson			0.18	ohms	PFC MOSFET Rdson - use high temp value from datasheet
Coss			22.00	pF	PFC MOSFET high voltage Coss from datasheet
tON			20.00	ns	MOSFET turnon current rise time. Check actual value
Qrr			76.40	nC	Average Qrr of boost diode over AC sinusoid
<b>PFC CHOKE Parameters</b>					
Lpfc			506.74	uH	PFC choke inductance
ILpk			7.28	A	PFC choke peak current at VACMIN
AL	380.00			nH/t <sup>2</sup>	nH per turn <sup>2</sup> (from magnetics datasheet). Note - This value decreases by as much as 15% if a belly-band is added to reduce EMI
n			36.52	turns	PFC choke number of turns
MLT	5.00			cm	Mean length per turn
AWG_Choke	22				PFC choke wire gauge
Equivalent Choke Metric Wire gauge			0.70	mm	Equivalent diameter of wire in metric units
Wire length			1.83	m	Length of wire used on PFC choke
Strands	3				Number of wires
DCR			34.94	m-ohms	DC resistance of wire at 25 C
DCR at 85 C			44.03	m-ohms	DC resistance of wire at 85 C
Irms_CHOKE			3.83	A	PFC choke rms current
DCR Cu loss			0.65	W	PFC choke DC Copper loss for reference at 85 C
ACR_PFC_Choke			88.05	m-ohms	Measure or calculate; add 26% to measured value to get 85 C value
HF Irms			0.77	A	RMS current of switching component
HF Cu loss			0.05	W	Copper loss due to switching component at 85 C
tot Cu loss			0.70	W	Total copper loss at 85 C
LM	10.00			cm	Magnetic path length of core used
Hpk			33.39	Oe	Peak MMF in Oersteds, calculated at low line
Hpk_SI			2658	A/m	Peak MMF in A/m, calculated at low line
<b>PFC FET, Diode and Output Parameters</b>					
Isense_R			0.06	ohms	Maximum value of PFC current sense resistor
Sense resistor power dissipation			0.87	W	PFC sense resistor power dissipation at Vacmin
Irms_FET			3.07	A	PFC MOSFET RMS current measured at VACMIN
Conduction loss			1.71	W	PFC MOSFET conduction loss
Trrloss			3.03	W	PFC MOSFET loss due to diode Trr
Cossloss			0.17	W	MOSFET Coss loss
Crossover loss			1.47	W	MOSFET crossover turnon loss
Total PFC loss			6.22	W	MOSPFC FET total loss
Diode bridge Ploss			4.56	W	Diode bridge estimated loss
PFC Diode RMS current			1.63	A	Approximate PFC Diode RMS current at nominal AC input voltage (VACMIN) (includes 100/120 Hz component)
Bulk capacitor RMS current			1.79	A	Approximate Bulk Capacitor RMS current at nominal AC input voltage (VACMIN) (includes 100/120 Hz component and LLC input current)

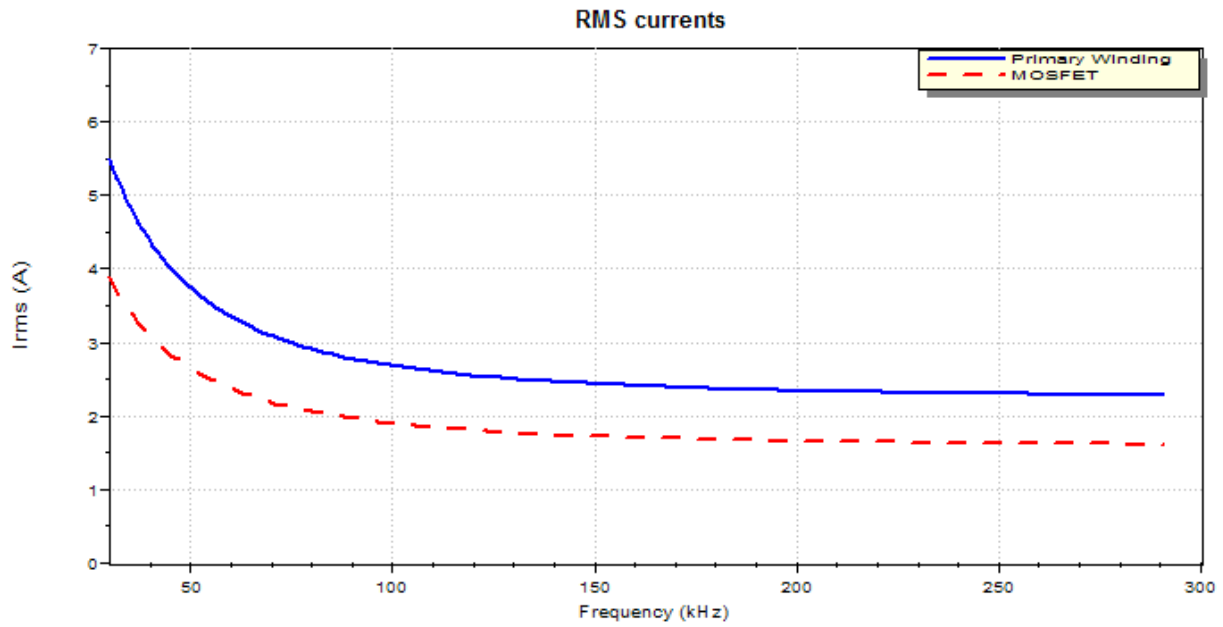


<b>LLC TRANSFORMER CALCULATIONS</b>					
Po			421.00	W	Output from LLC converter including diode loss
Vo			42.10	V	Output at transformer windings (includes diode drop)
Ae	1.25			cm^2	Transformer core cross-sectional area
Lpar	200.00		200.00	uH	Parallel inductance. (Lpar = Lopen - Lser for integrated transformer; Lpar = Lmag for non-integrated transformer)
Lser	60.00		60.00	uH	Leakage inductance of integrated transformer; Leakage + external inductor for non-integrated transformer
Lopen			260.00	uH	Primary open circuit inductance for integrated transformer
C	47.00		47.00	nF	Series resonant capacitor
fnominal_desired			94.40	kHz	Desired full load switching frequency. Recommended value 66 kHz to 132 kHz
fnominal_actual			94.4	kHz	Expected frequency at nominal input voltage (VBULK) and full load
IRMS_LLC_Primary			2.75	A	Primary winding RMS current at full load and nominal input voltage (VBULK)
IRMS_LLC_Q1			1.94	A	RMS current through upper MOSFET in LLC half bridge
VMIN			258.1	V	Minimum Voltage on Bulk Capacitor at minimum switching frequency
f_AT_VMIN			51.00	kHz	Frequency at minimum Bulk capacitor voltage
fpar			52	kHz	Parallel resonant frequency (defined by Lpar + Lser and C)
fser			95	kHz	Series resonant frequency (defined by series inductance Lser and C)
fmin			54	kHz	Min frequency, at VBULK_MIN and full load. Set PLC810 minimum frequency to this value. Operation below this frequency results in loss of ZVS
NP_1			30		Primary winding number of turns
NS_1	6.00		6		Secondary winding number of turns
n_RATIO	5.00		5.00		Transformer turns ratio. Adjust this value so that fnominal_actual is close to fnominal_desired
Bpkfmin			2599	Gauss	First Quadrant peak flux excursion at minimum frequency.
BAC			2973	Gauss	AC peak to peak flux density (calculated at fnominal_actual, VBULK at full load)
LLC sense resistor			0.07	ohms	LLC current sense resistor
Pdiss_LLC_senseR			0.51	W	Power dissipation in LLC sense resistor
<b>PRIMARY</b>					
Primary gauge	40.00			AWG	Individual wire strand gauge used for primary winding
Equivalent Primary Metric Wire gauge			0.08	mm	Equivalent diameter of wire in metric units
Primary litz strands	125.00				Number of strands used in Litz wire; for non-litz non-integrated transformer set to 1
Primary parallel wires	1.00				Number of parallel individual wires to make up Litz wire
Resistivity_25 C_Primary			29.83	m-ohm/m	Resistivity in milli-ohms per meter
Transformer primary MLT	7.00			cm	Mean length per turn
Primary turns			30.00		Number of primary turns
Primary DCR 25 C			62.65	m-ohm	Estimated resistance at 25 C
Primary DCR 100 C			83.95	m-ohm	Estimated resistance at 100 C (approximately 33% higher than at 25 C)
Primary RMS current	1.50			A	Measured RMS current through the primary winding
ACR_Trf_Primary			134.32	m-ohm	Measured AC resistance (at 100 kHz, room temperature), multiply by 1.33 to approximate 100 C winding temperature
Primary copper loss			0.30	W	Total primary winding copper loss at 85 C
<b>Winding 1 (Vo1)</b>					
					Note - Power loss calculations are for each winding half

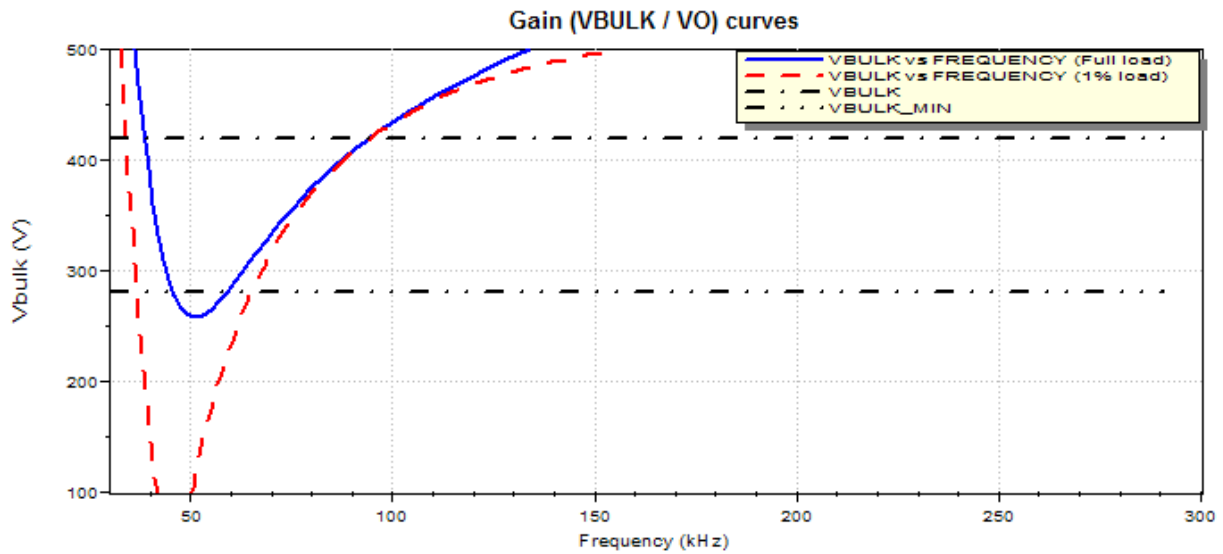
					of secondary
Sec 1 Wire gauge	40			AWG	Individual wire strand gauge used for secondary winding
Equivalent secondary 1 Metric Wire gauge			0.08	mm	Equivalent diameter of wire in metric units
Sec 1 litz strands	175				Number of strands used in Litz wire; for non-litz non-integrated transformer set to 1
Parallel wires sec 1	2				Number of parallel individual wires to make up Litz wire
Resistivity_25 C_sec1			10.65	m-ohm/m	Resistivity in milli-ohms per meter
Transformer Secondary MLT	7.00			cm	Mean length per turn
Sec 1 Turns			6.00		Secondary winding turns (each half)
DCR_25C_Sec1			4.47	m-ohm	Estimated resistance at 25 C (for reference)
DCR_100C_Sec1			6.00	m-ohm	Estimated resistance at 100 C (approximately 33% higher than at 25 C)
Sec 1 RMS current			15.72	A	RMS current through Output 1 winding, assuming half sinusoidal waveshape
DCR_Ploss_Sec1			1.20	W	Estimated Power loss due to DC resistance (both secondary halves)
ACR_Sec1			9.59	m-ohm	Measured AC resistance (at 100 kHz, room temperature), multiply by 1.33 to approximate 100 C winding temperature . Default value of ACR is twice the DCR value at 100 C
ACR_Ploss_Sec1			4.74	W	Estimated AC copper loss (both secondary halves)
Total secondary winding Copper Losses			5.94	W	Total (AC + DC) winding copper loss for both secondary halves
<b>Total Copper loss calculation</b>					Does not include fringing flux loss from gap
Primary copper loss (from Primary section)			0.30	W	Total primary winding copper loss at 85 C
Secondary copper Loss			5.94	W	Total copper loss in secondary winding
Transformer copper loss			6.24	W	Total copper loss in transformer (primary + secondary)
<b>URNS CALCULATOR</b>					This is to help you choose the secondary turns - not connected to any other part of spreadsheet
V1			41.40	V	Target Output Voltage Vo1
V1d1			0.70	V	Diode drop voltage for Vo1
N1	4.00				Total number of turns for Vo1
V2			20.35	V	Expected outputV
V2d2			0.70	V	Diode drop voltage for Vo2
N2	2.00				Total number of turns for Vo2



Full load Primary and MOSFET RMS currents



V<sub>BULK</sub> vs Switching Frequency





## 11 Performance Data

All measurements were taken at room temperature unless otherwise specified, with 50 Hz input frequency. Voltage measurements were taken at the connectors.

**Important Notice:** due to component availability LLC measurements have been performed using MBR30H150 diodes which have significantly larger voltage drop compared to what has been selected in the BOM/schematic, therefore the reported measurements represent a worst case. Document will be updated as soon as MBR30H60 will be available.

### 11.1.1 Composite Efficiency

Composite efficiency is shown in Figure 20 for 20% load, 50% load, and 100% load.

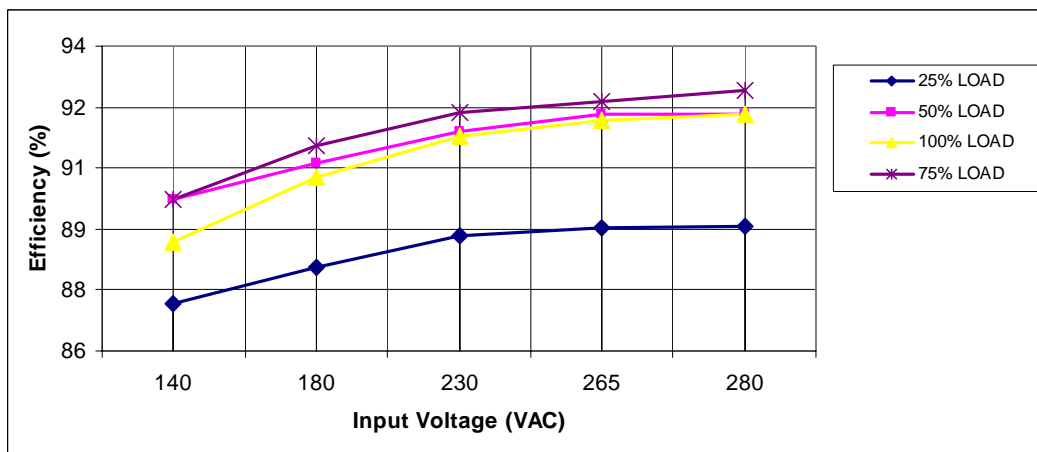


Figure 14 – PFC/LLC Composite Efficiency vs. Output Power,

### 11.2 Standby Load Input Power

These values were taken when the 5V flyback output was loaded with 50mA and the 12V output was loaded with 20mA.

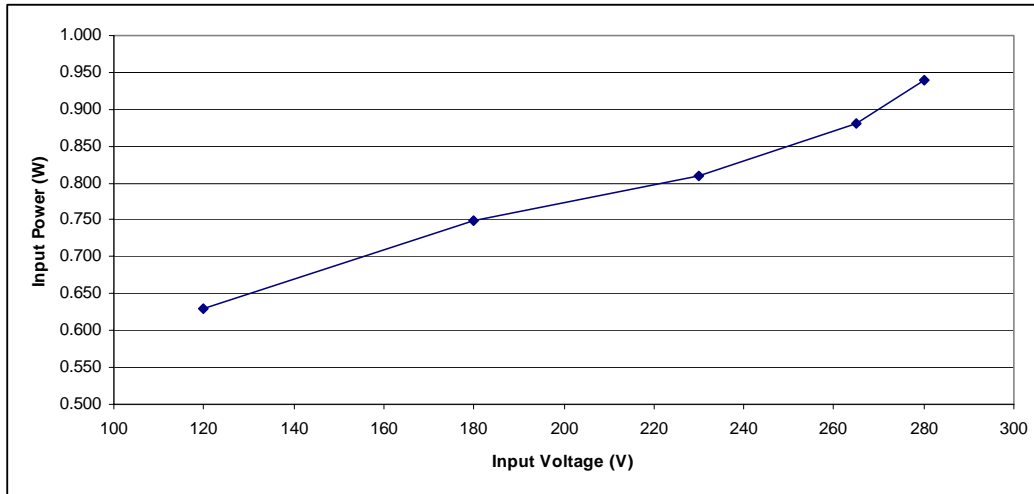


Figure 15 – Standby Power with Remote Off

#### 11.2.1 No-Load Input Power

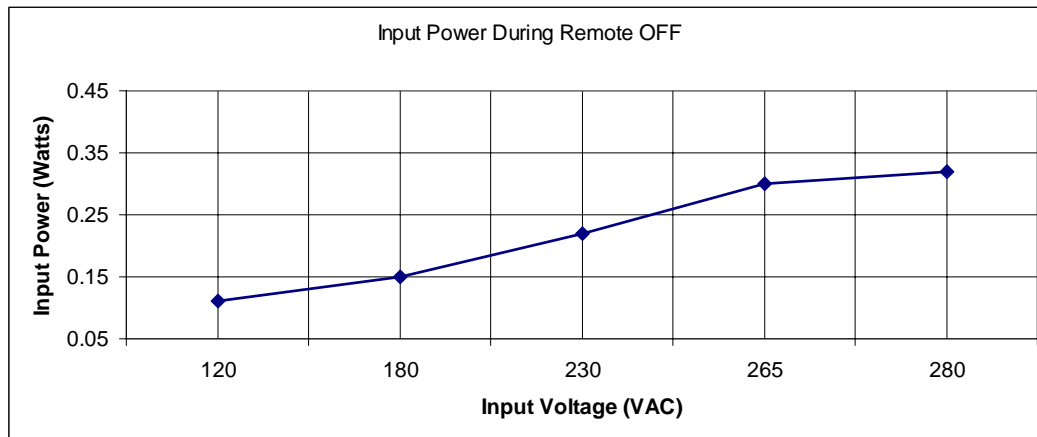
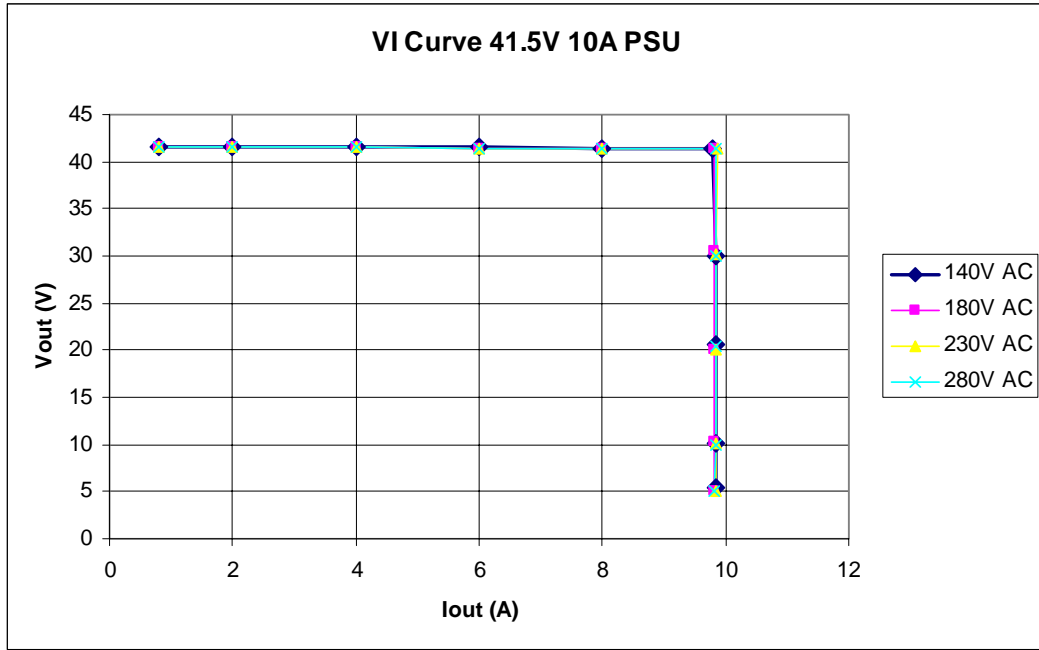


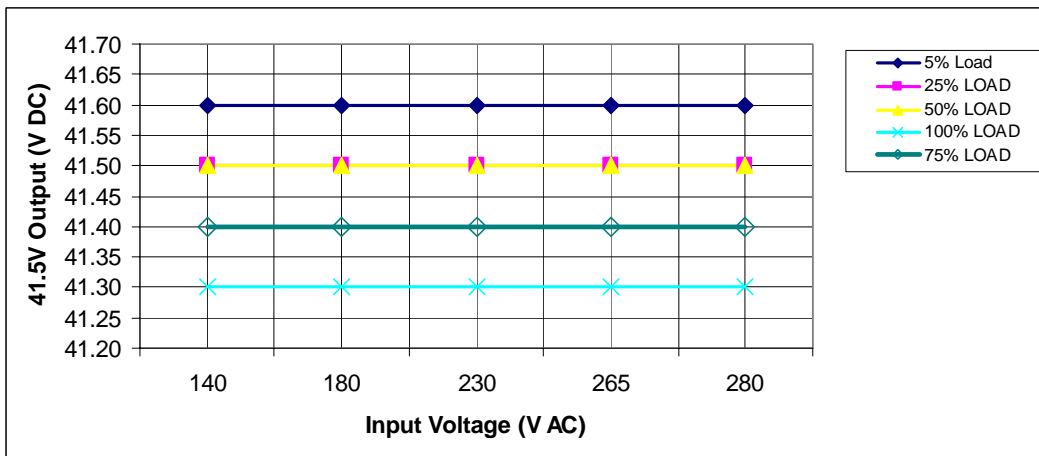
Figure 16 – Zero Load Input Power vs. Input Line Voltage, Room Temperature, 50 Hz.

**11.3 CV/CC Regulation**



**Figure 17 – Output Regulation (CC/CV)**

The graph shows the output voltage variation with load. The PFC regulates the LLC input voltage under normal conditions so the outputs will not be affected by the AC input voltage.



**Figure 18 – Output Regulation (CV Only)**

### 11.4 Power Factor and Total Harmonic Distortion

These values were measured directly on the AC network, where Voltage harmonics are present and contribute to additional THD on the current. Results will be updated with an AC Power Supply.

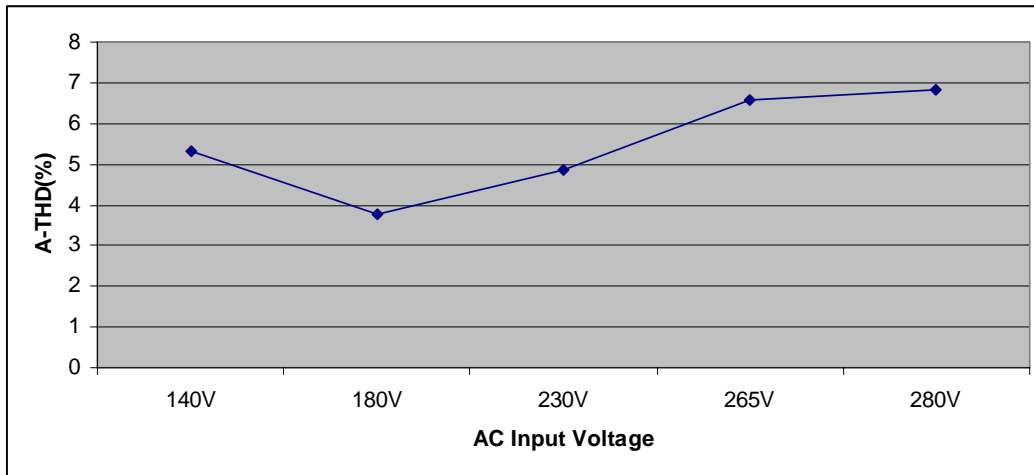


Figure 19 – Current THD vs Input Voltage, 100% load

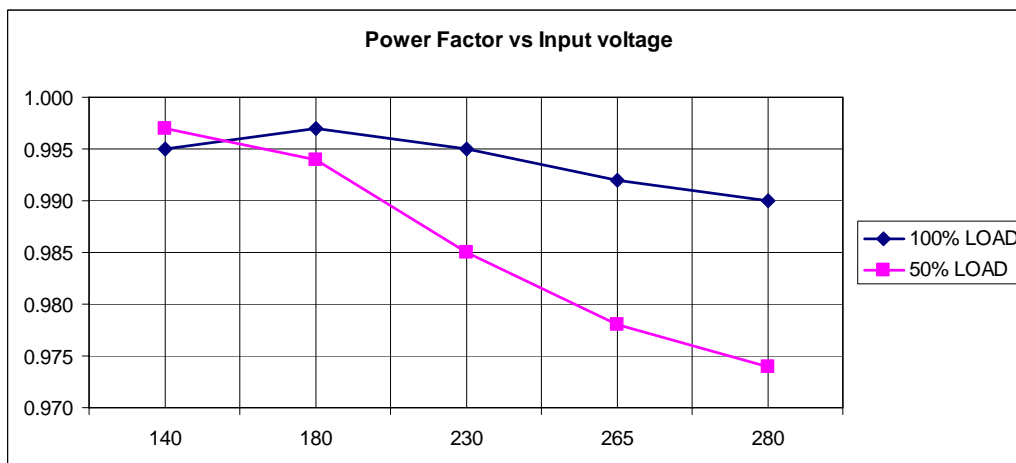


Figure 20 – Power Factor vs. Input Voltage, 50% and 100% load

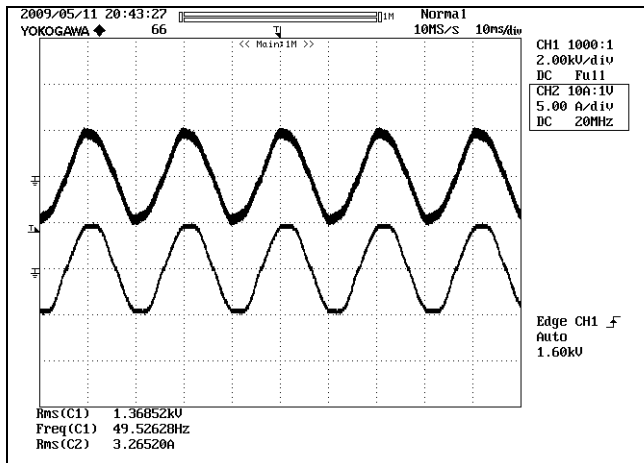
## 12 Thermal Performance

### 12.1 Operating Temperature Survey

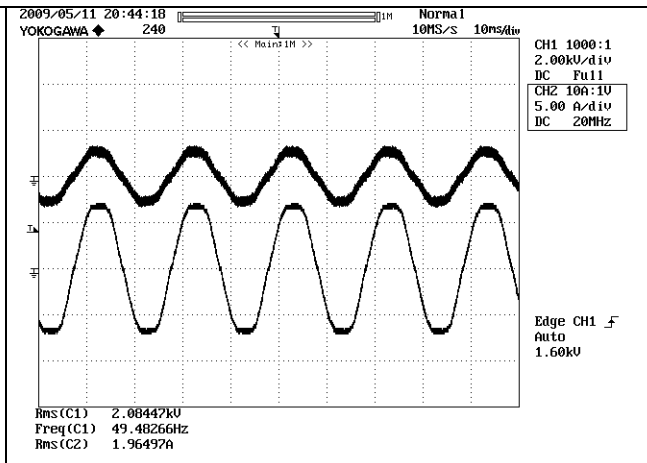
	PFC HS	PFC IND	LLC TX Core	LLC TX Winding	LLC FET	LLC SEC HS	AMB
230 VAC	40	49	81	86	73	73	25

### 13 Waveforms

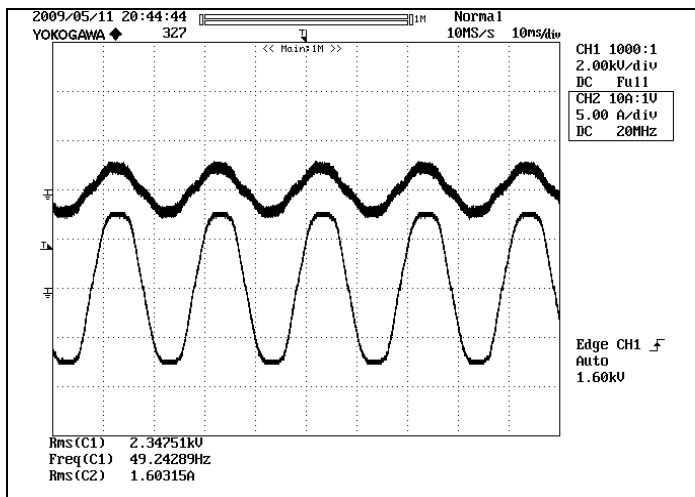
#### 13.1 Input Voltage and Current



**Figure 21** – 140VAC, 414W load  
Top trace – Input Current, 5A/div  
Bottom trace – Input Voltage, 200V,  
10ms/div

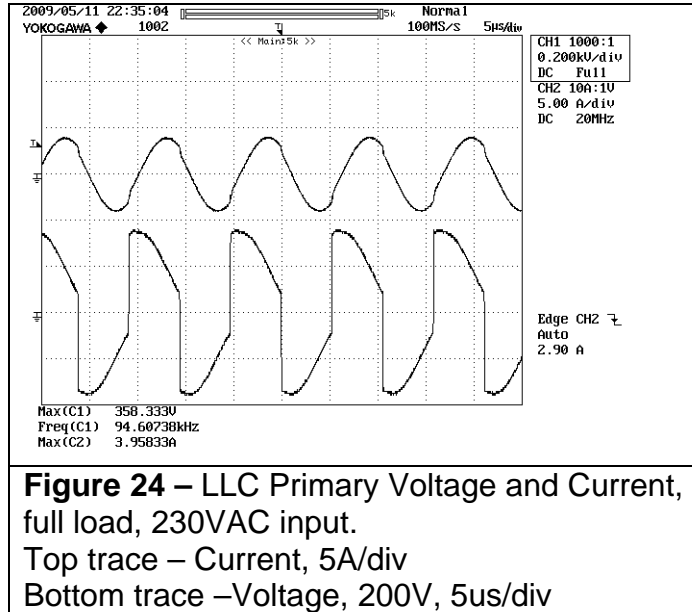


**Figure 22** – 230VAC, 414W load  
Top trace – Input Current, 5A/div  
Bottom trace – Input Voltage, 200V,  
10ms/div

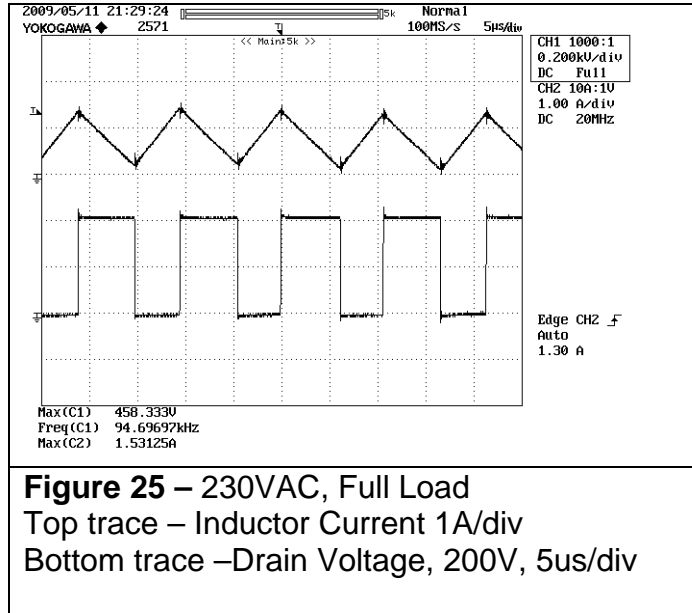


**Figure 23** – 280VAC, 414W load  
Top trace – Input Current, 5A/div  
Bottom trace – Input Voltage, 200V, 10ms/div

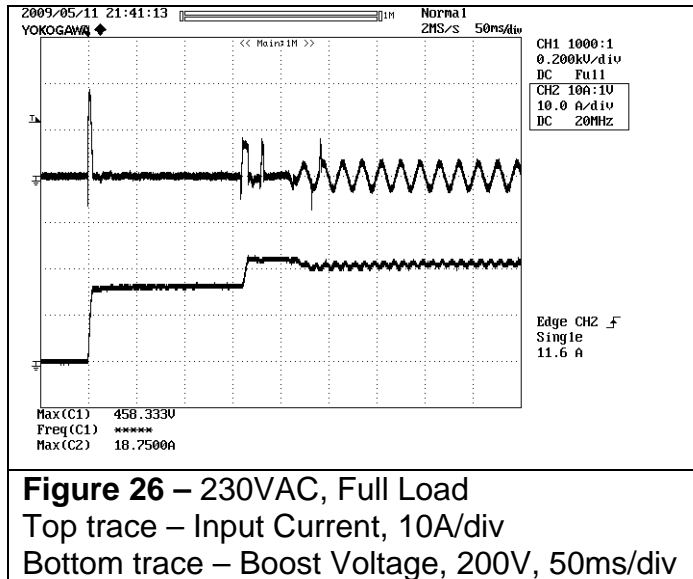
**13.2 LLC Resonating Capacitor Voltage and Current, Normal Operation**



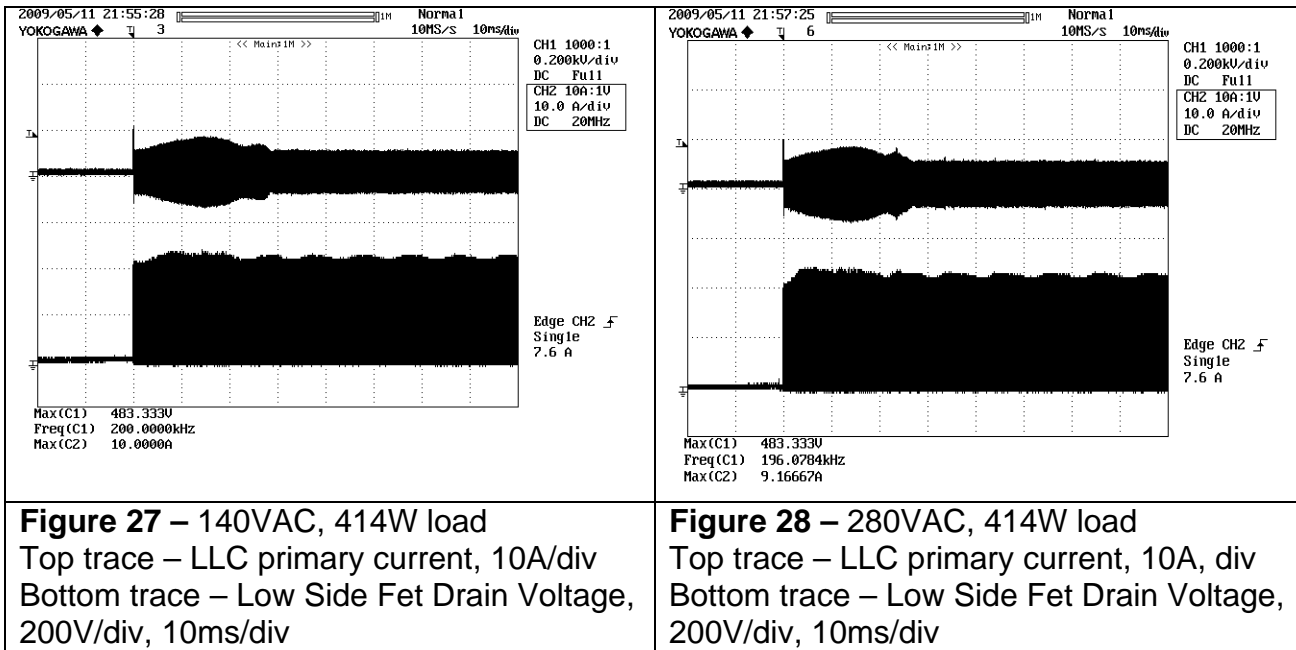
**13.3 PFC Stage Voltage and Current – Normal Operation**



### 13.4 AC Input Current and PFC Output Voltage - Startup



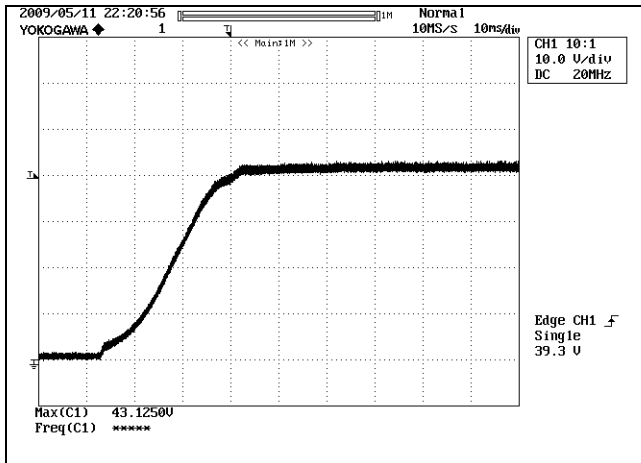
### 13.5 LLC Startup



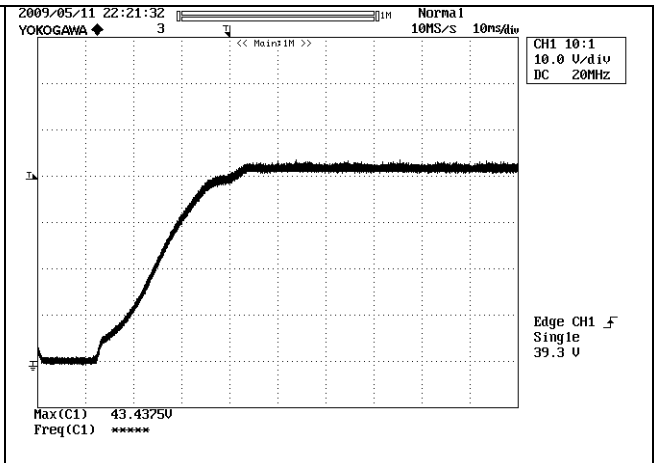


### 13.6 Output Voltage during Startup and Shutdown

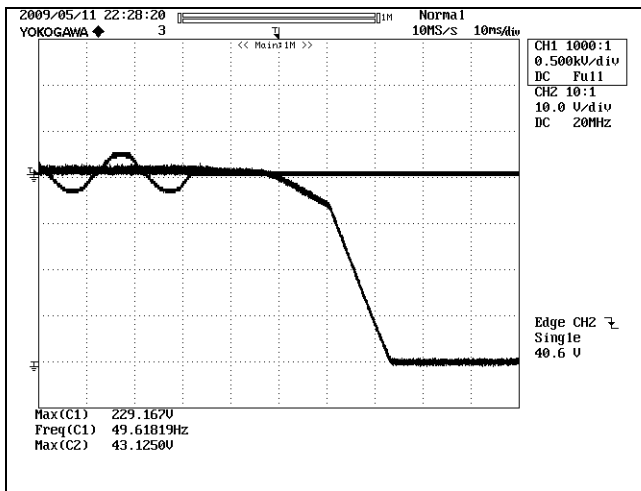
#### 13.6.1 LLC Output



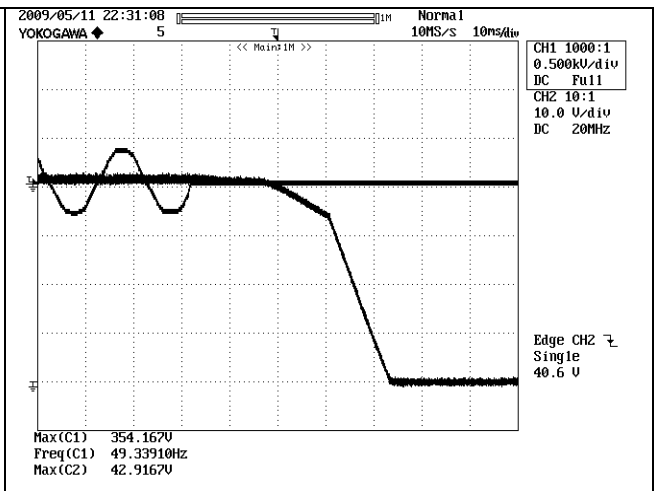
**Figure 29** – 41.4V output at startup  
140VAC, Full load on main output 10V,  
10ms/div



**Figure 30** – 41.4V output at startup  
280VAC, Full load on main output 10V,  
10ms/div



**Figure 31** – 41.4V output at shutdown  
140VAC, Full load on main output  
Top trace – AC Input Voltage 500V/div  
Bottom trace – Output Voltage, 500V,  
20ms/div



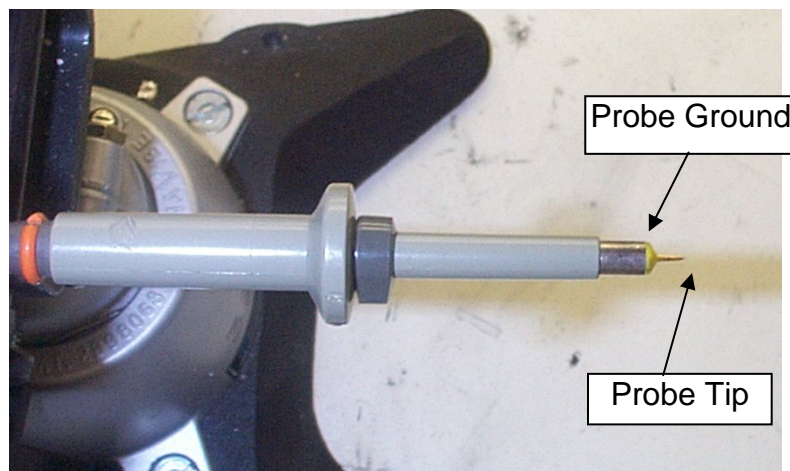
**Figure 32** – 41.4V output at shutdown  
230VAC, Full load on main output  
Top trace – AC Input Voltage 500V/div  
Bottom trace – Output Voltage, 10V,  
10ms/div

## 13.7 Output Ripple Measurements

### 13.7.1 Ripple Measurement Technique

For DC output ripple measurements, use a modified oscilloscope test probe to reduce spurious signals. Details of the probe modification are provided in the figures below.

Tie two capacitors in parallel across the probe tip of the 4987BA probe adapter. Use a  $0.1 \mu\text{F}$  / 50 V ceramic capacitor and  $1.0 \mu\text{F}$  / 50 V aluminum electrolytic capacitor. The aluminum-electrolytic capacitor is polarized, so always maintain proper polarity across DC outputs.

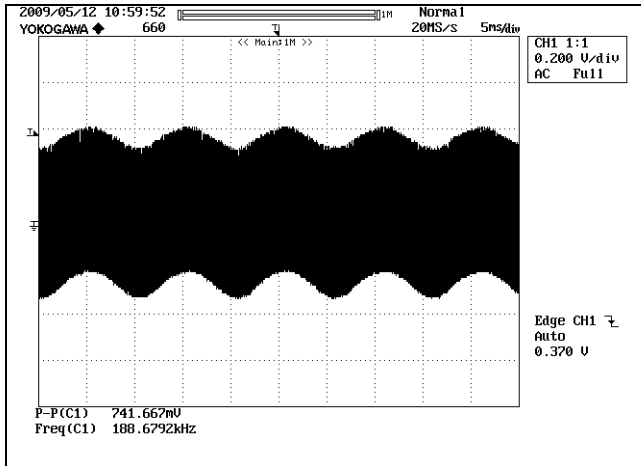


**Figure 33** – Oscilloscope Probe Prepared for Ripple Measurement (End Cap and Ground Lead Removed).

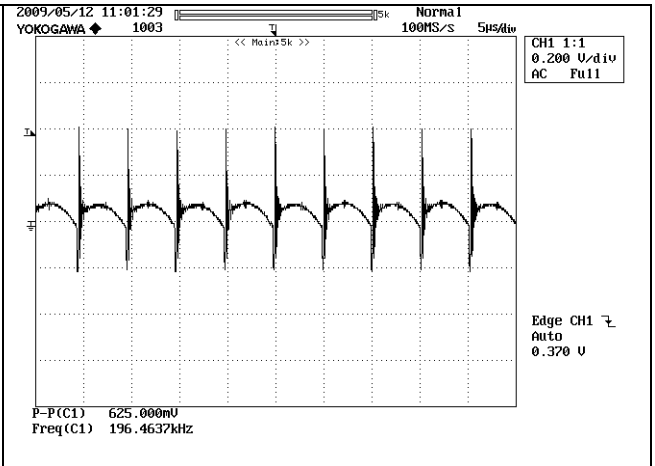


**Figure 34** – Oscilloscope Probe with Probe Master 4987BA BNC Adapter (Modified with Wires for Probe Ground for Ripple measurement and Two Parallel Decoupling Capacitors Added).

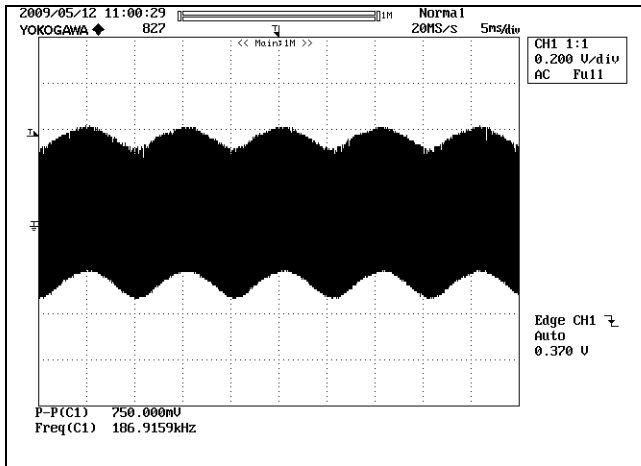
13.7.2 24V Ripple Measurement Results



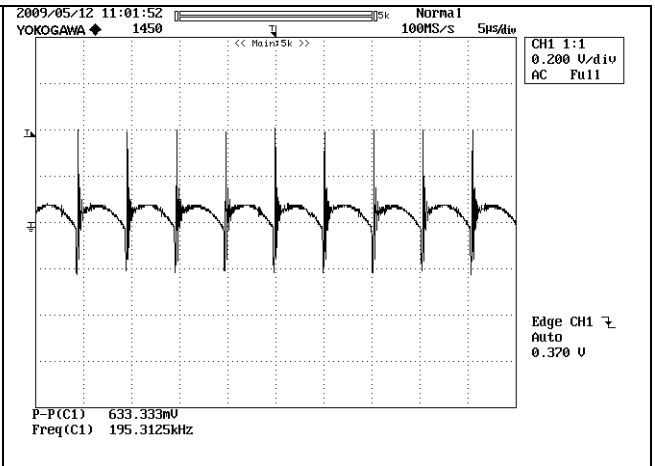
**Figure 35** – 41.4V Output Low Frequency Ripple, 140VAC Input, Max Load, 200 mV, 5 msec/div



**Figure 36** – 41.4V Output High Frequency Ripple, 140VAC Input, Max Load, 200 mV, 5 µsec/div



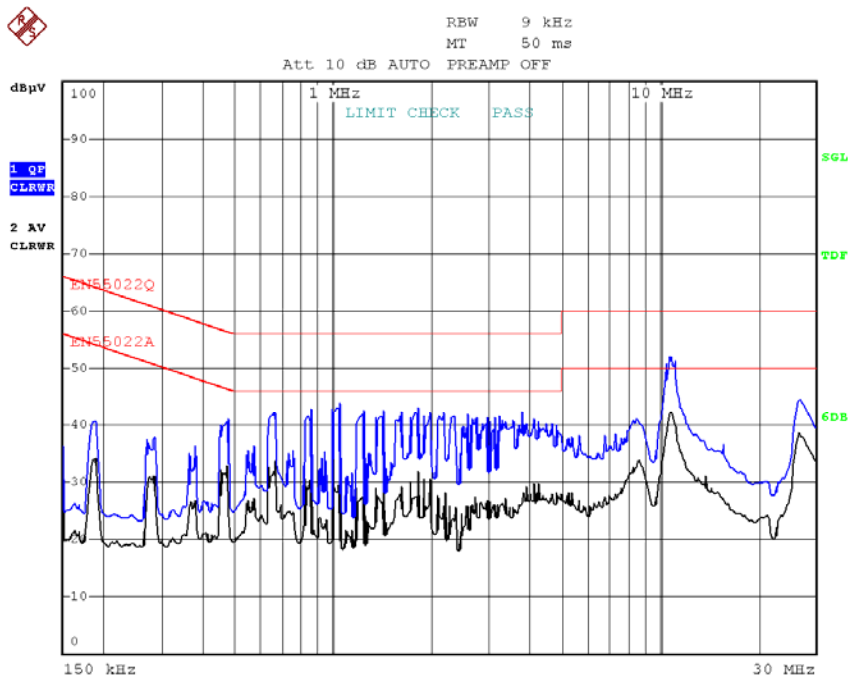
**Figure 37** – 41.4V Output Low Frequency Ripple, 230VAC Input, Max Load, 200 mV, 5 msec/div



**Figure 38** – 41.4V Output High Frequency Ripple, 230VAC Input, Max Load, 200 mV, 5 µsec/div

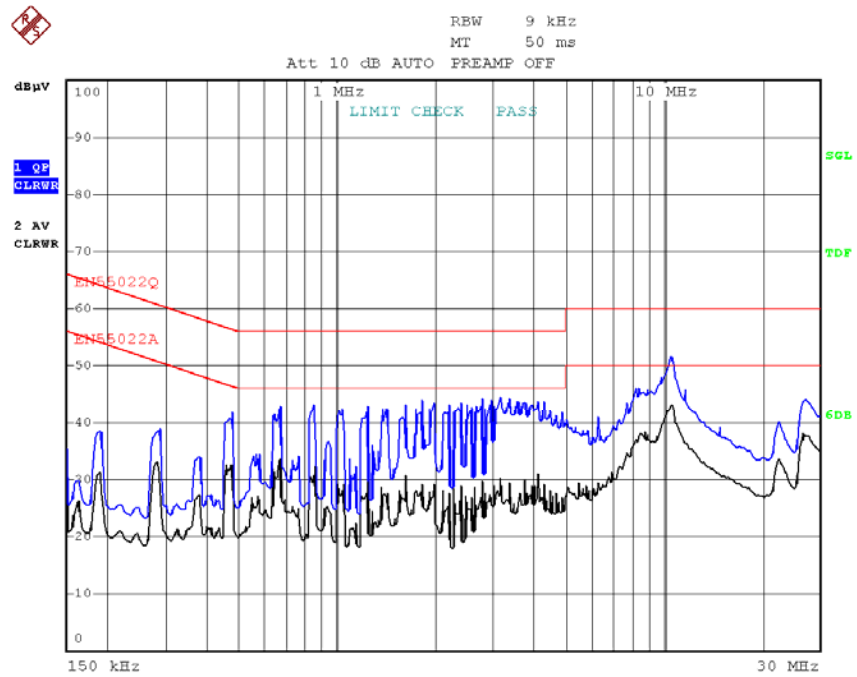
## 14 Conducted EMI

Conducted EMI tests were performed with a 41.4 Ohm load connected to the LLC output. The board was bolted to a metallic ground plane, which in turn was hard wired to LISN ground.



Date: 11.MAY.2009 11:30:28

Figure 39 - Conducted EMI, 230VAC L test.



Date: 11.MAY.2009 11:41:11

Figure 40 - Conducted EMI, 230VAC N test

## 15 Revision History

Date	Author	Revision	Description and changes	Reviewed
11-May-09	MU	0.1	First draft	MU

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